

Model Name : Z5W1M
File Name : LA-B511P

Compal Confidential

EA52_BM UMA M/B Schematics Document

Intel Bay Trail M

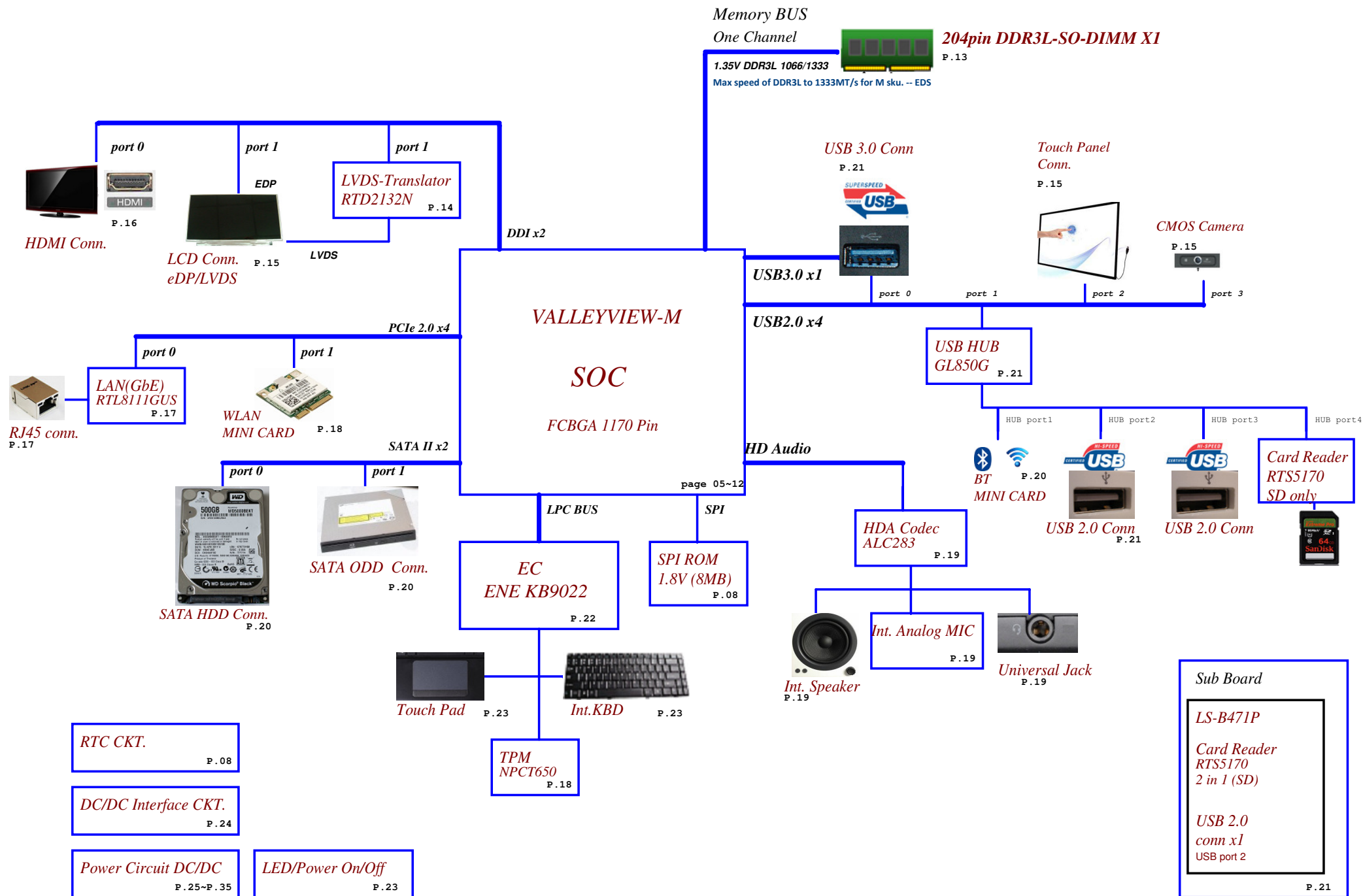
2014-03-13

REV: 1.0

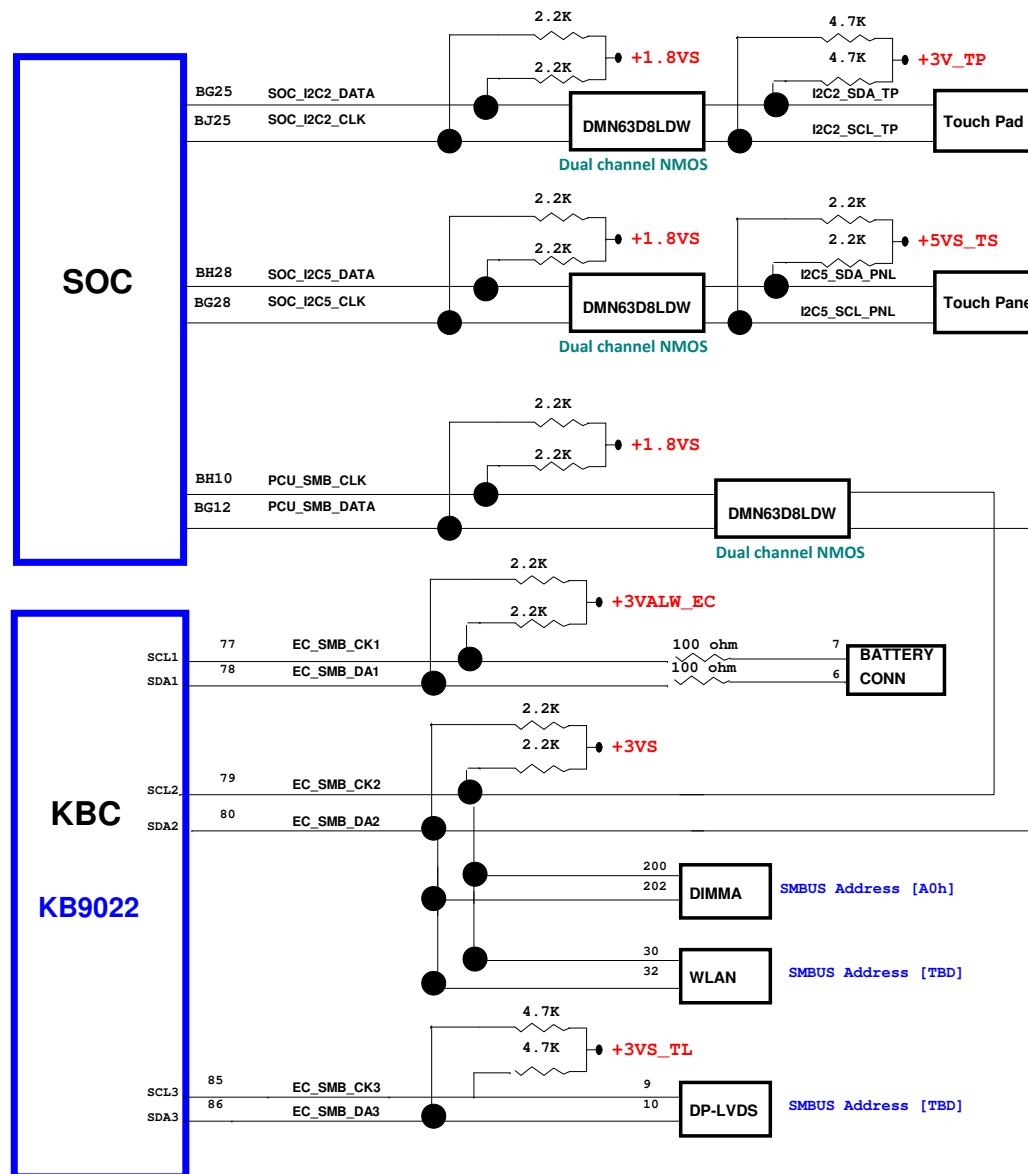
PCB@
DAX_PCB 12R LA-B211P REV0 M/B

Part Number	Description
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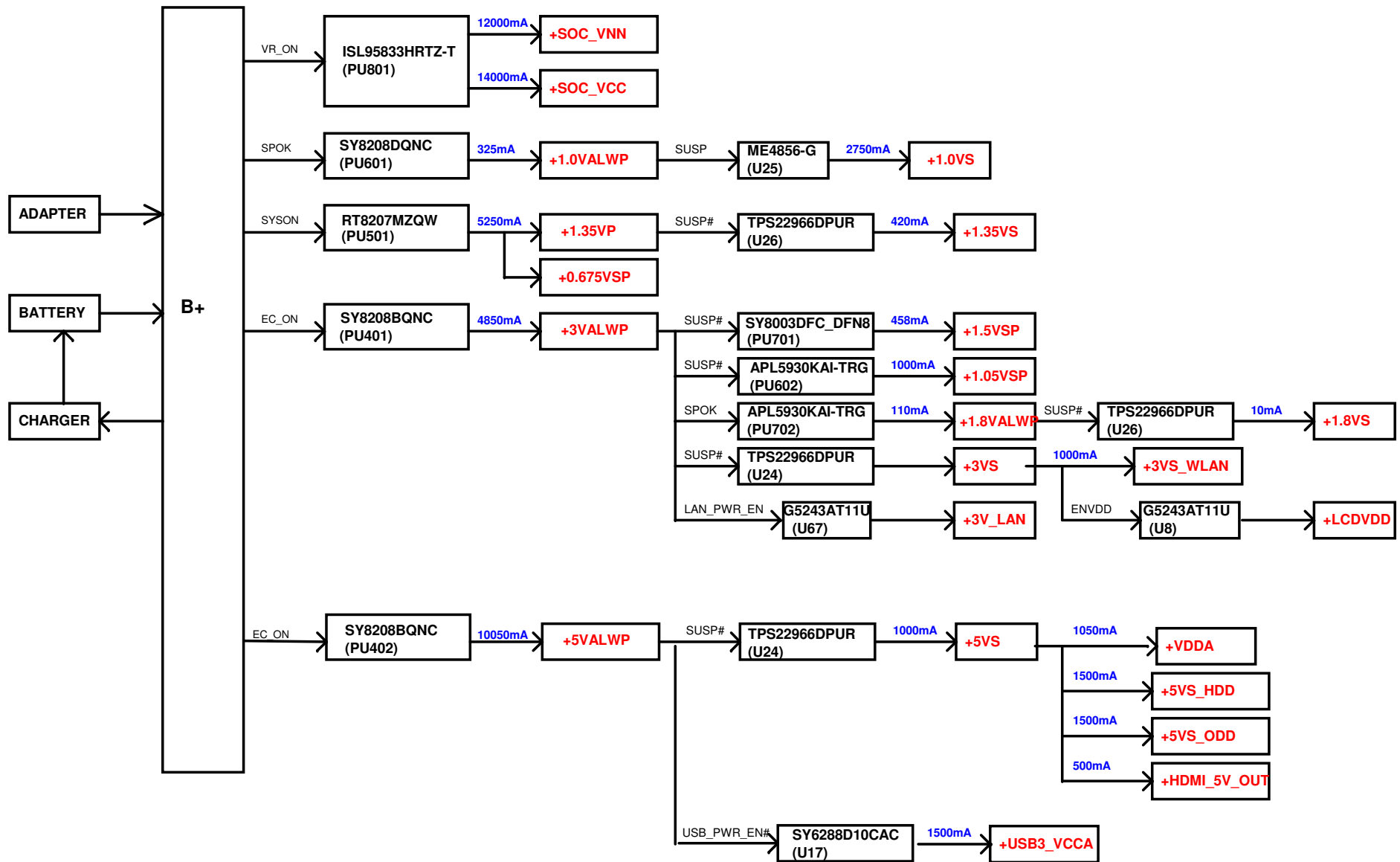
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				Date: Thursday, March 13, 2014	Sheet 1	of 39



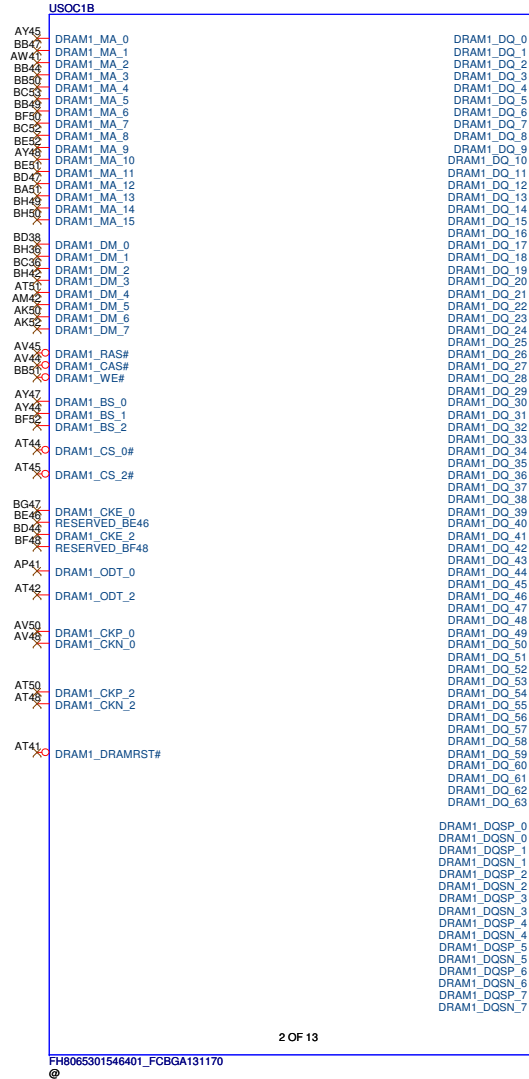
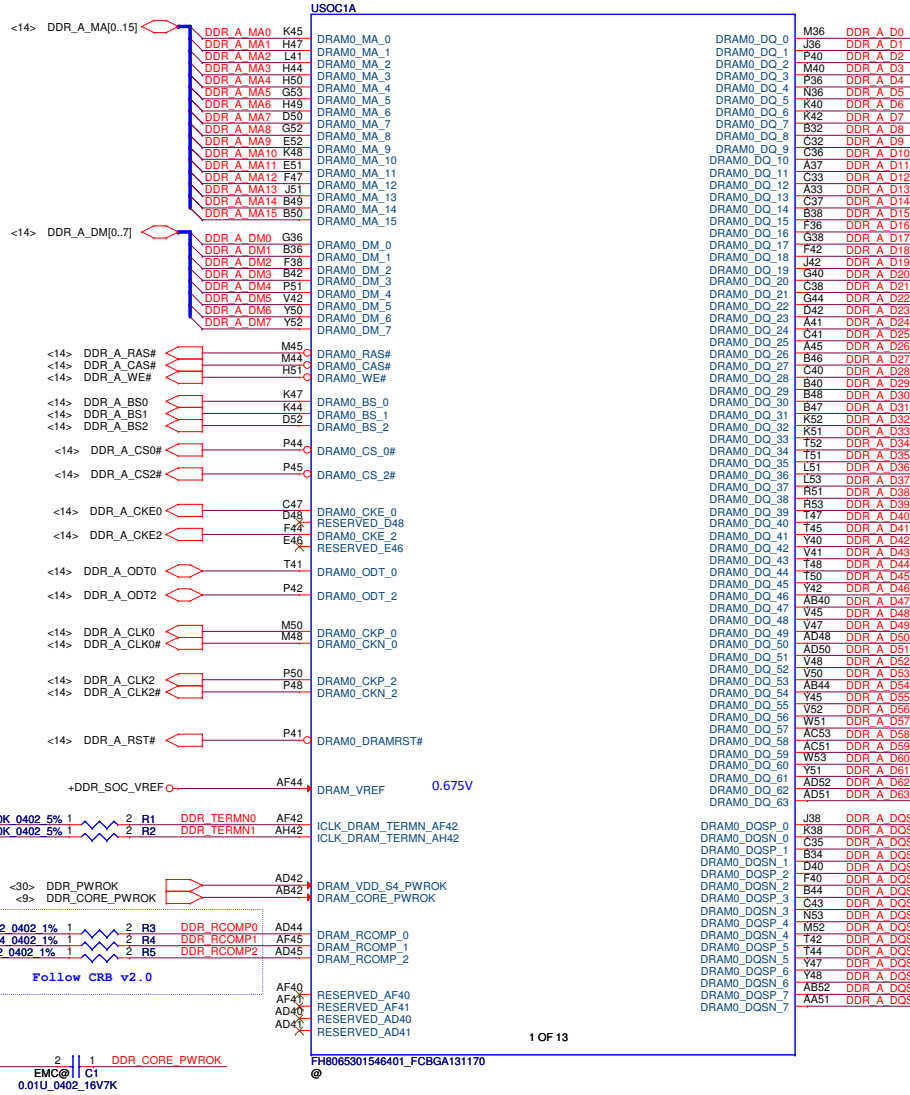
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				Rev	1.0



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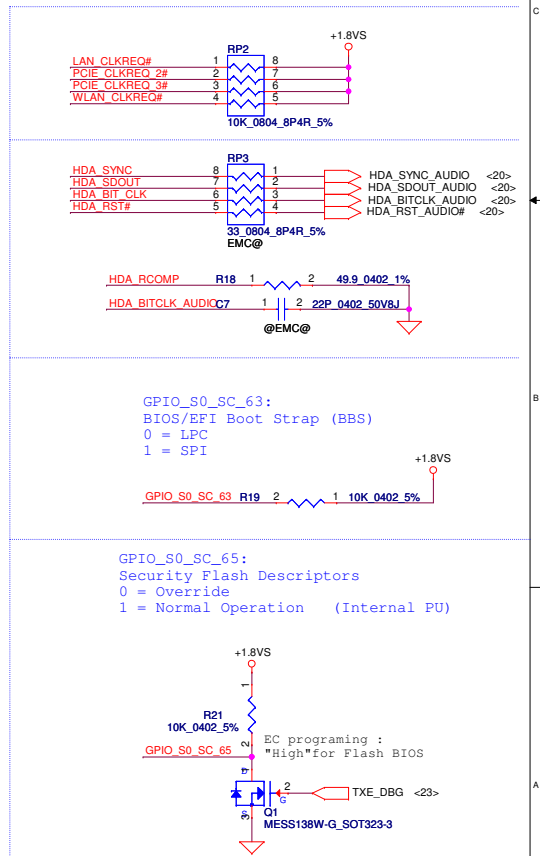
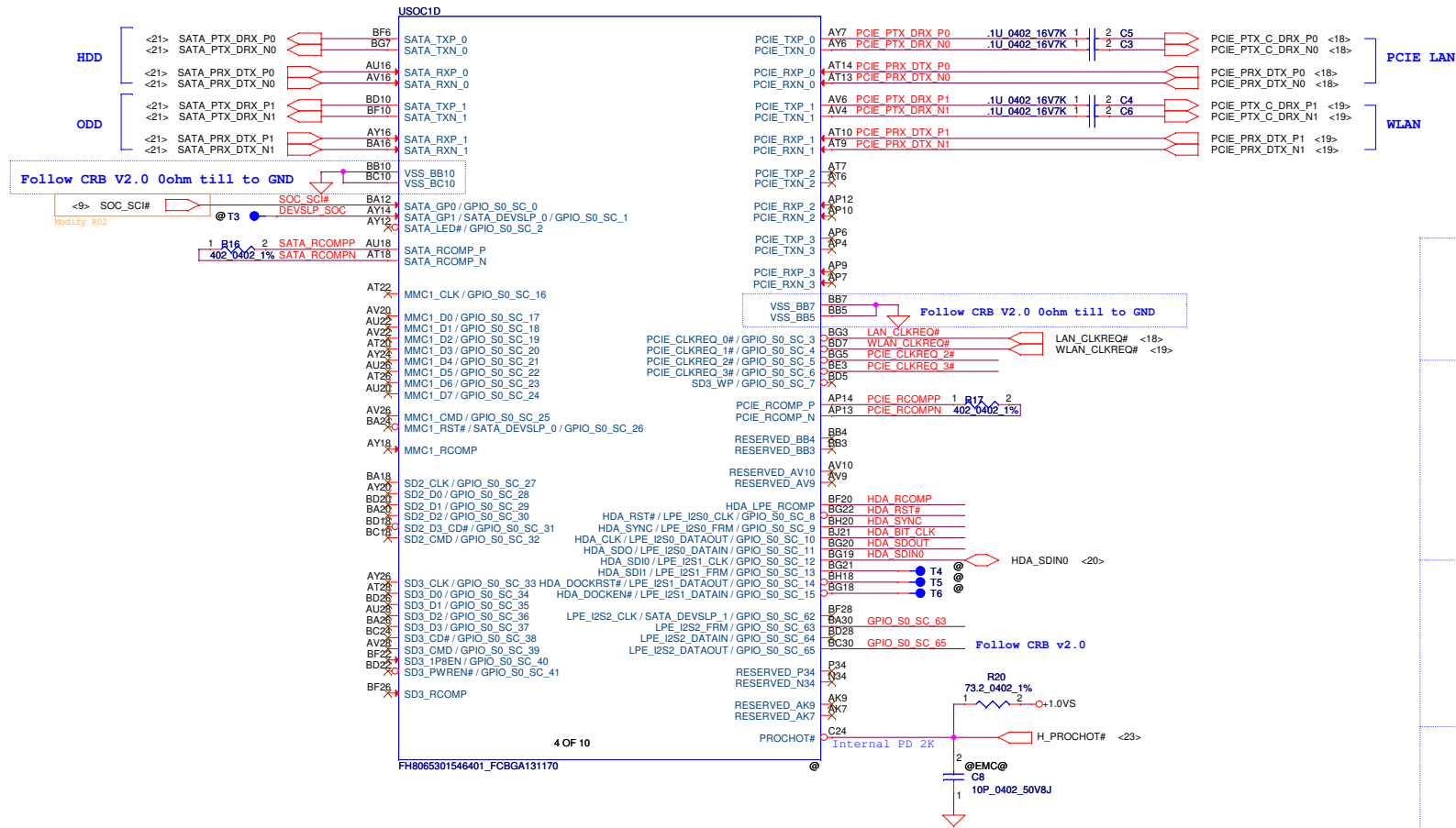


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Part Number = SA00007QG70

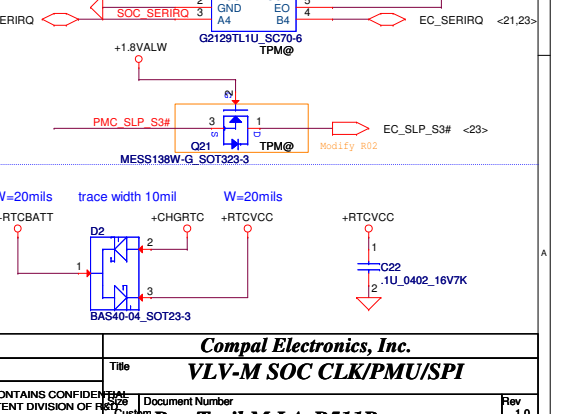
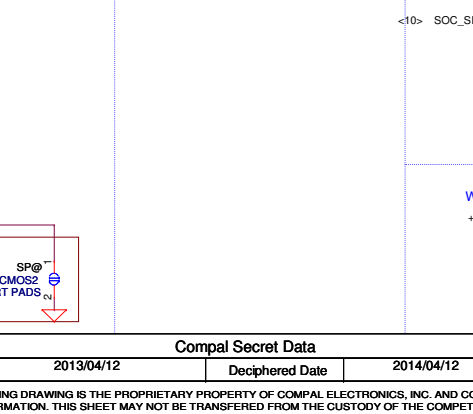
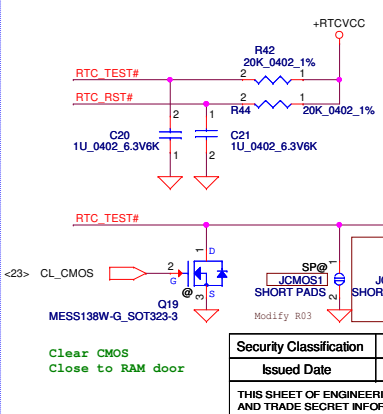
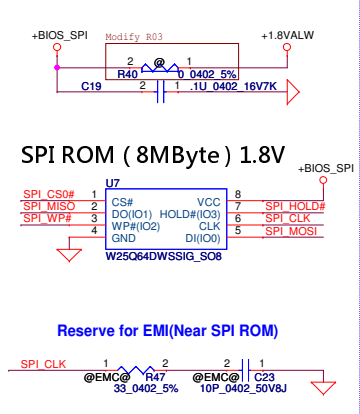
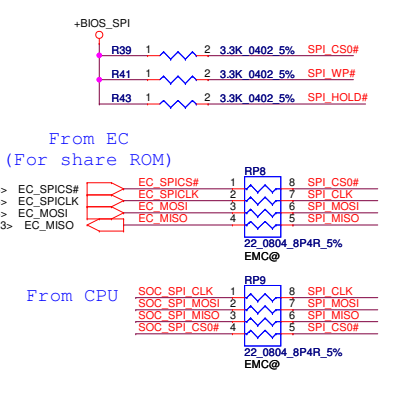
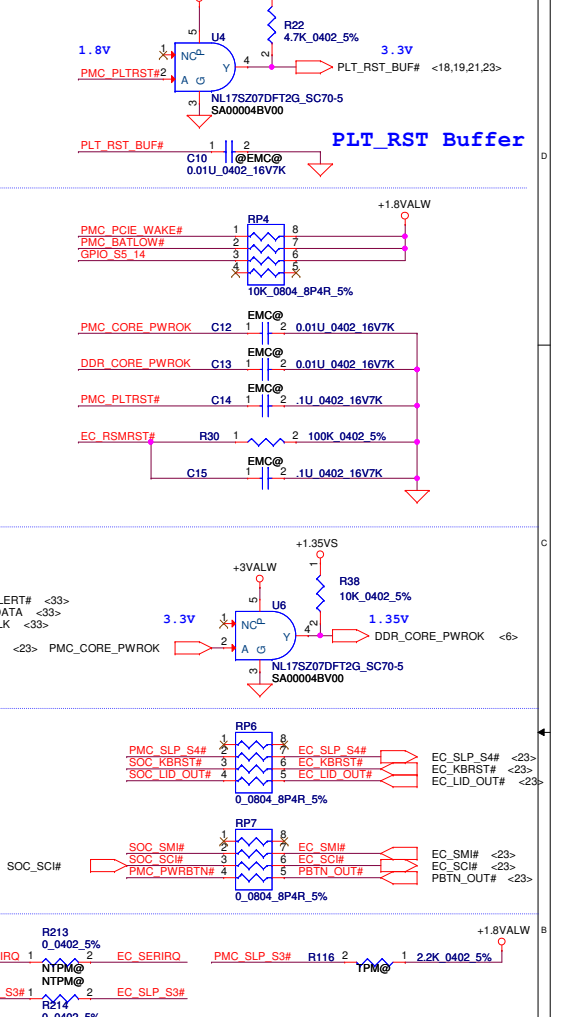
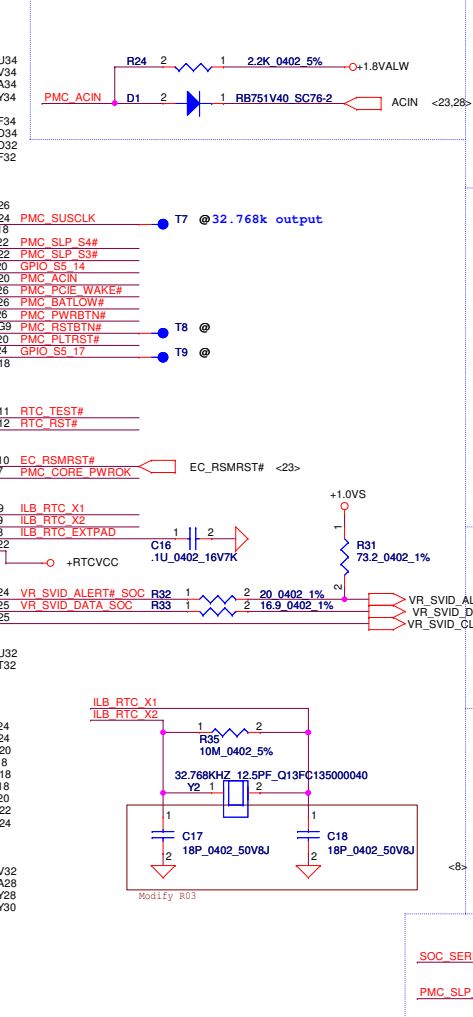
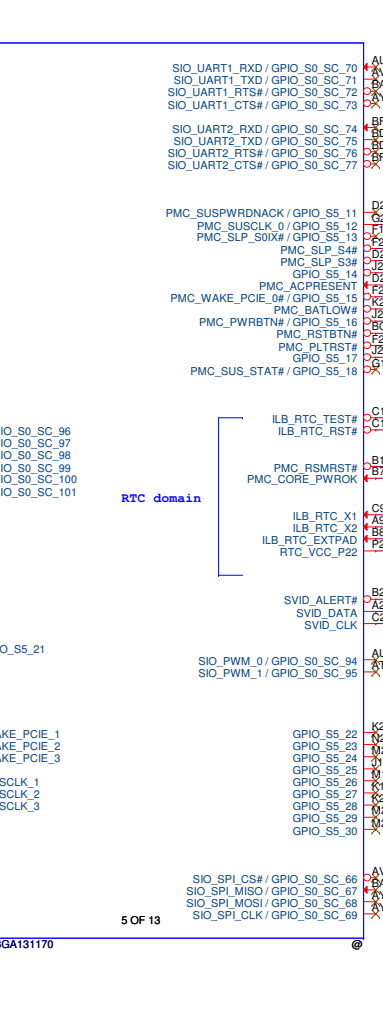
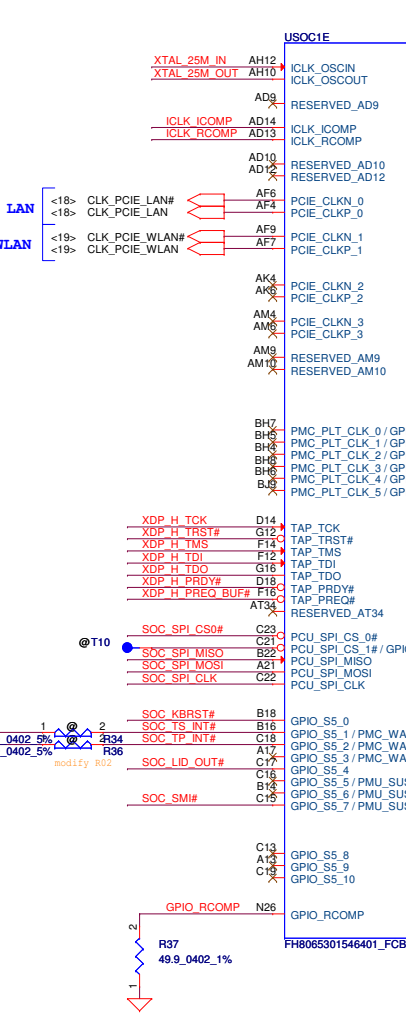
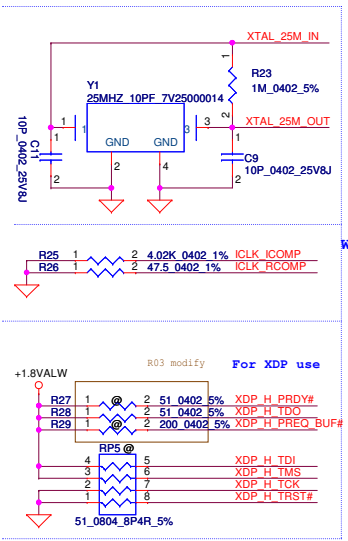
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Part Number = SA00007QR30

USOC1
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Part Number = SA00007R770

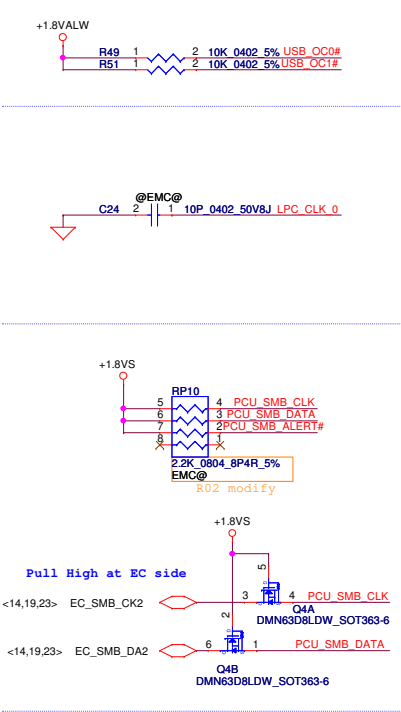
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Compal Electronics, Inc.			VLV-M SOC Memory DDR3L	
Bay Trail M LA-B511P			Date: Thursday, March 13, 2014 Sheet 6 of 39	



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				VLV-M SOC SATA/PCI-E/HDA	
				Document Number	
				Rev	
				Bay Trail M LA-B511P	
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				Customer	
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USB3.0 Connector

USB Hub

Touch Panel

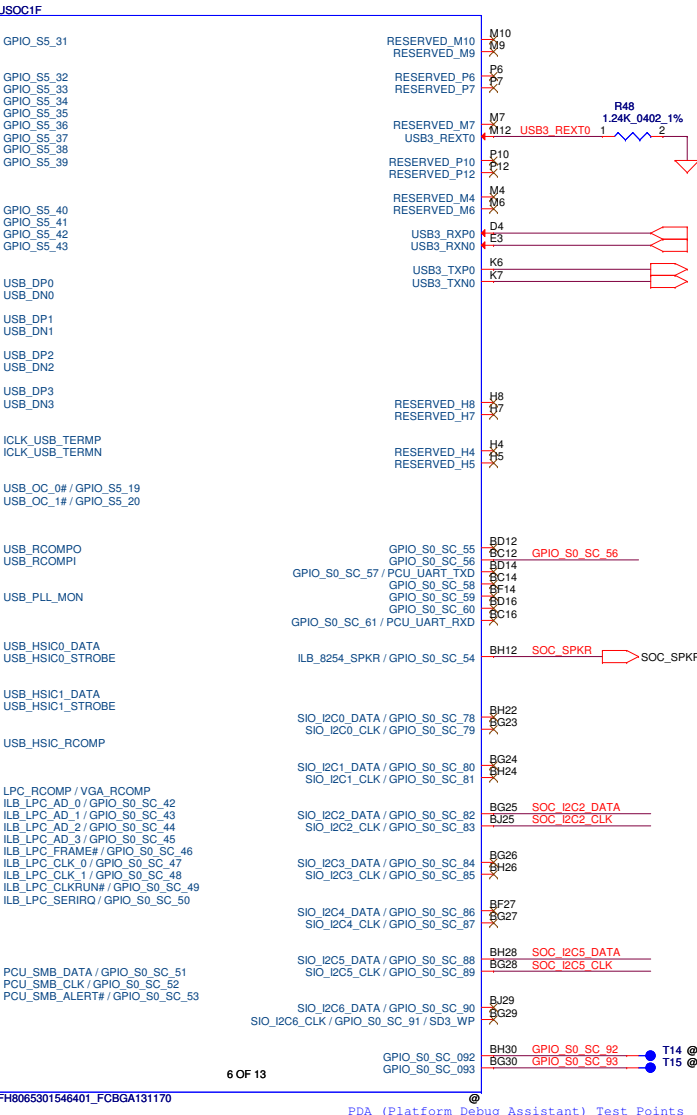
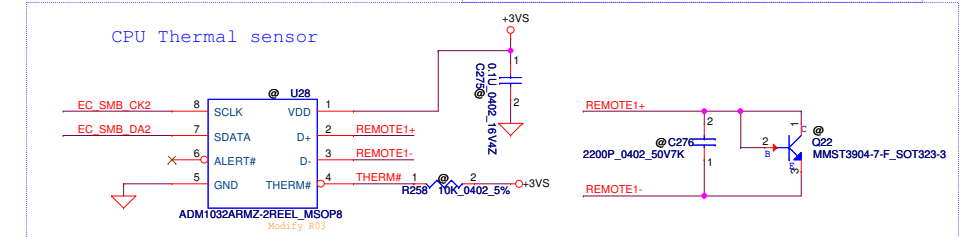
Camera

NOTE: Ref checklist rev1.2 p.24
USB_PLL_MON is a single ended signal and should follow single ended signal routing requirements.

NOTE: Ref checklist rev1.2 p.25
USB_HSIC_RCOMP must NOT float if they are not being used.

ILB_LPC_CLK_0 : Output of 25MHz,
Need Check with EC

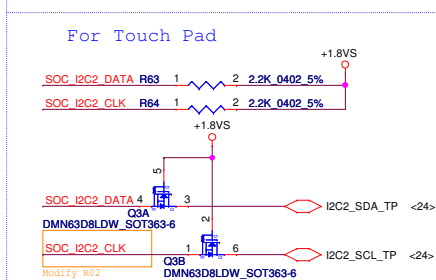
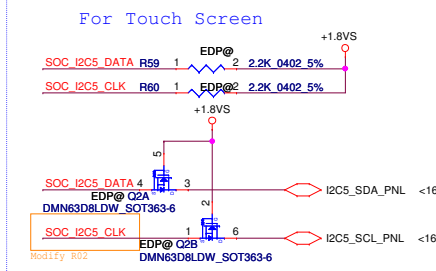
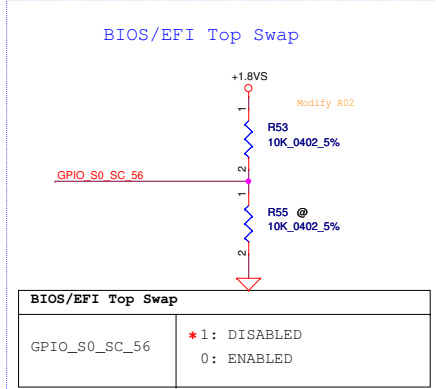
ILB_LPC_CLK_1 is for CLK_0 feedback.(Input)
Set to Output for Normal Usage



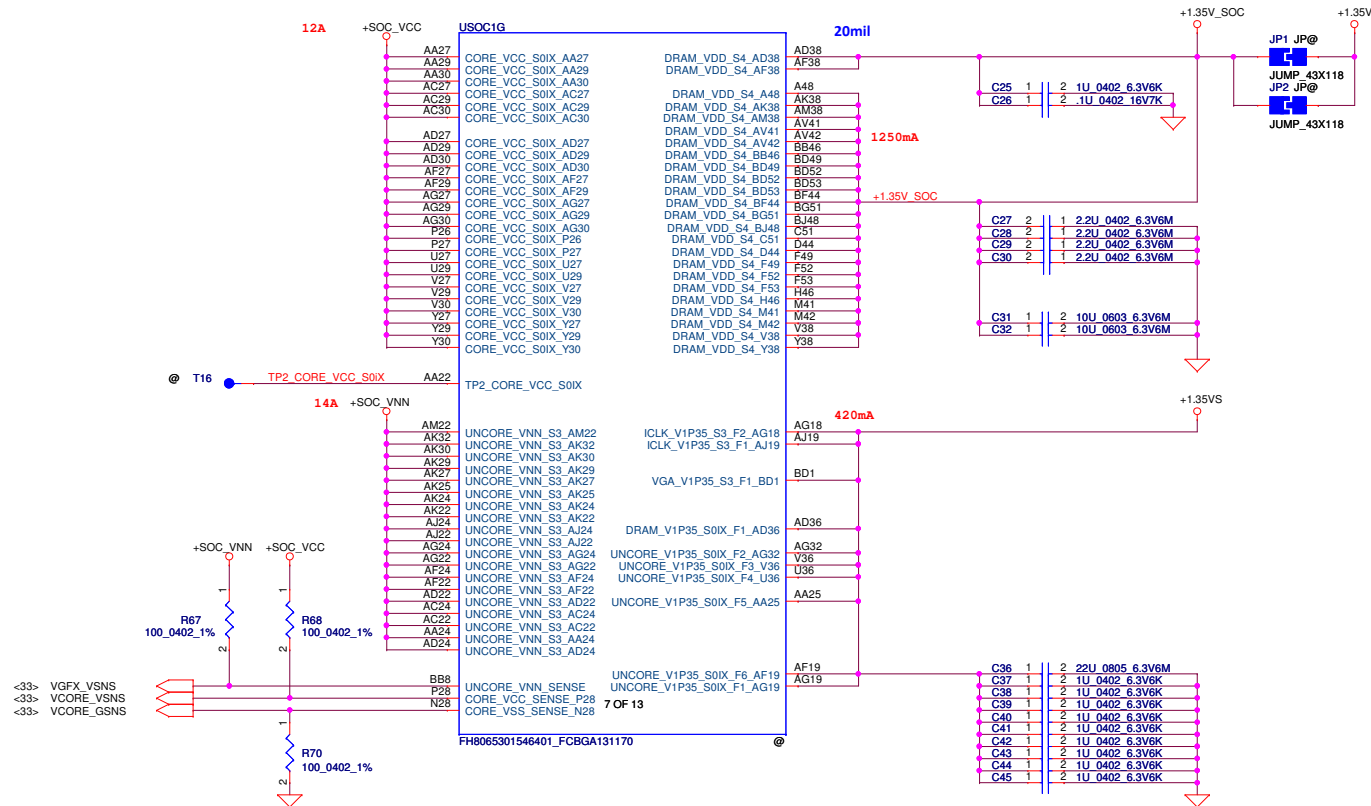
BIOS/EFI Top Swap

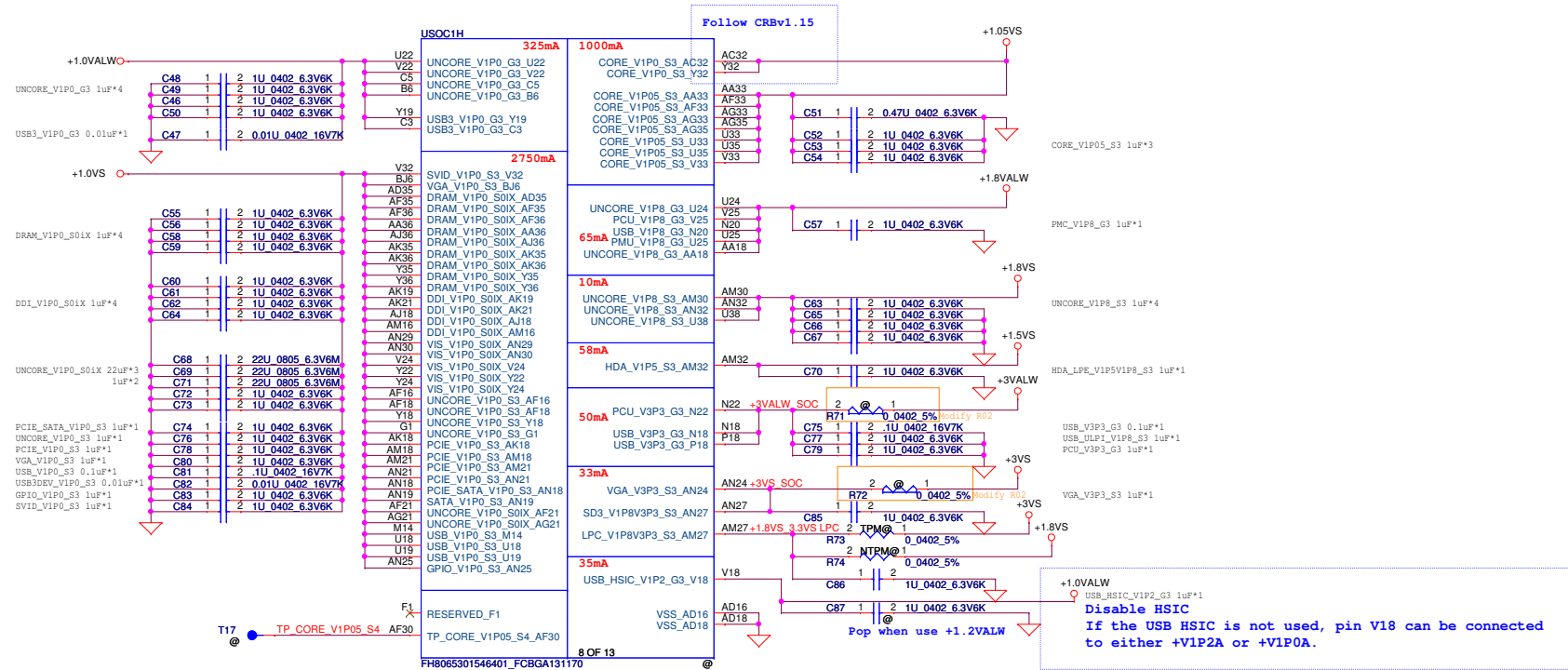
While updating the BIOS/EFI boot sector in flash, unexpected system power loss can cause an incomplete write resulting in a corrupt boot sector.

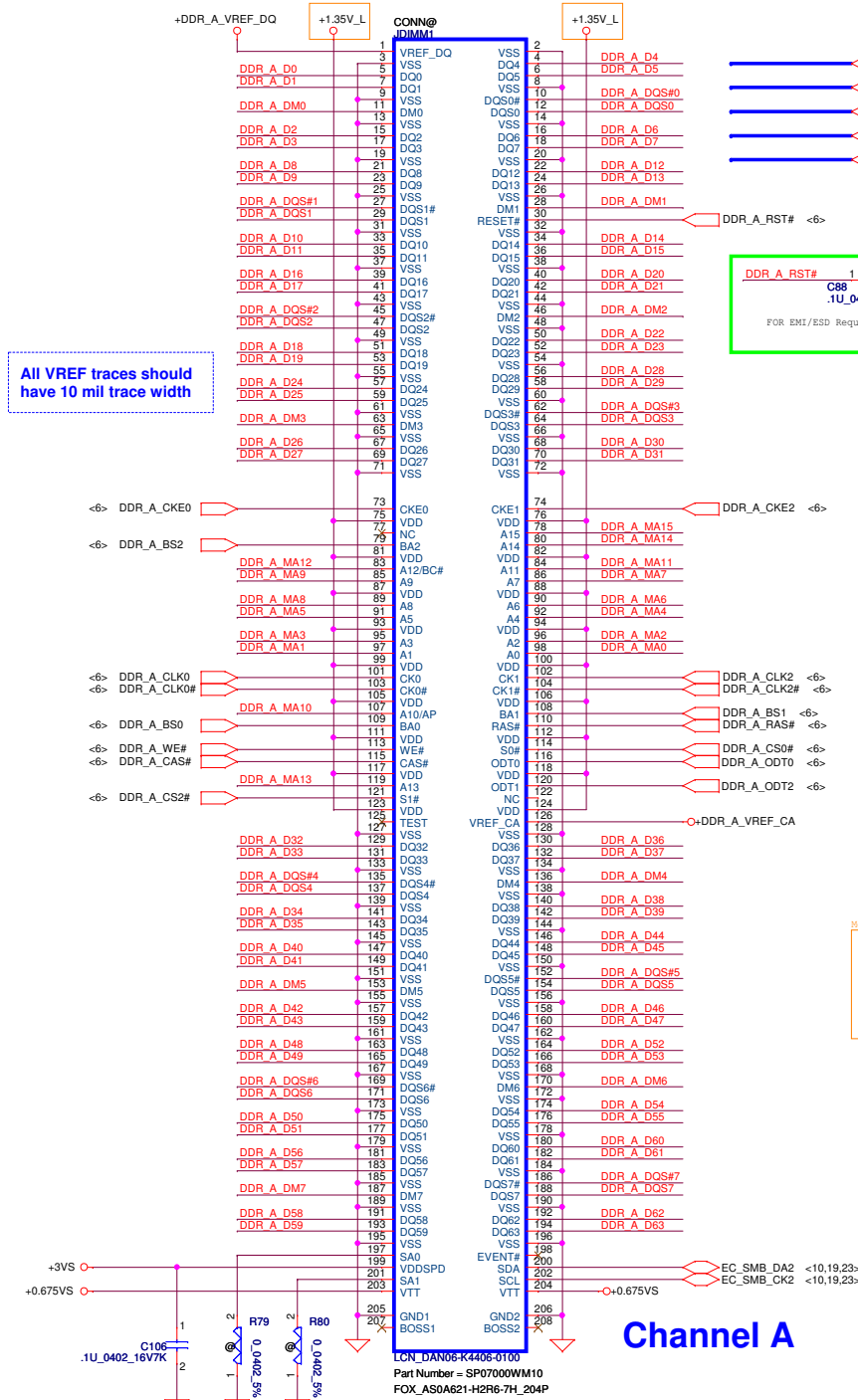
Reference EDS v1.5 Page2294



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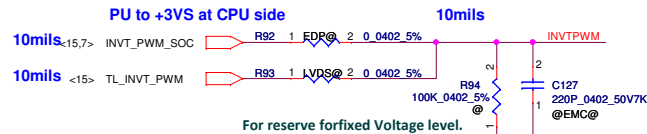
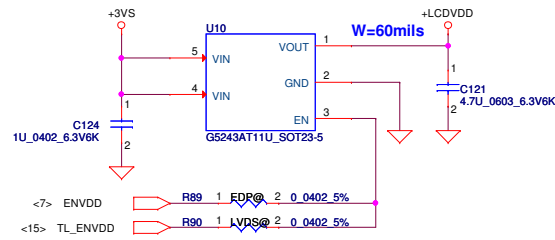


Channel A

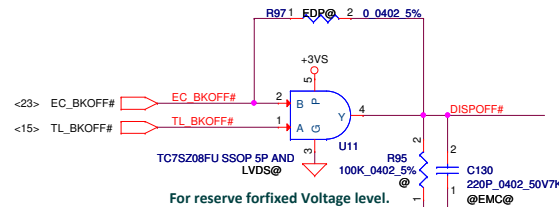
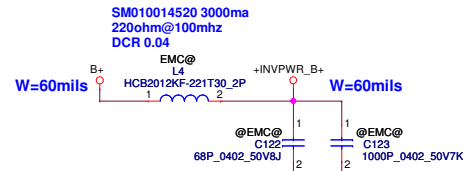
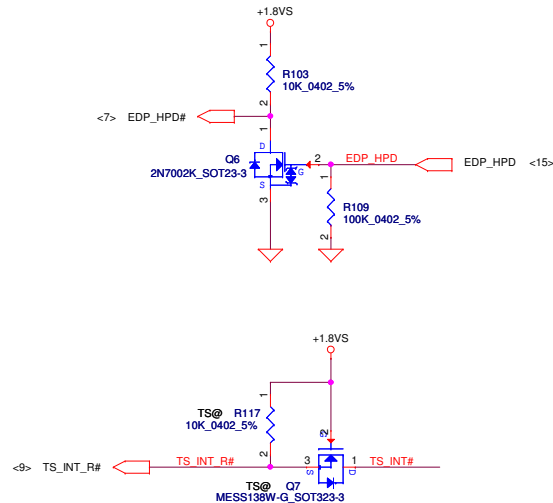
<Address: SA1:SA0=00 (A0H)>
DIMM_1 STD H:4mm

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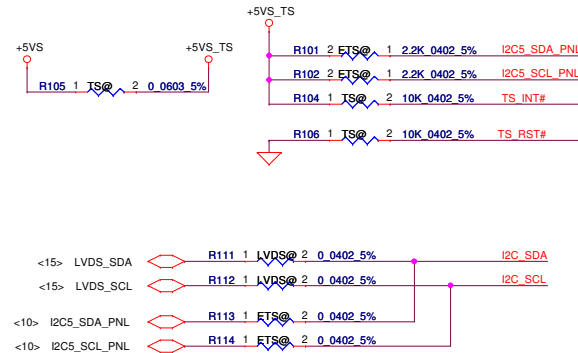
LCD POWER CIRCUIT



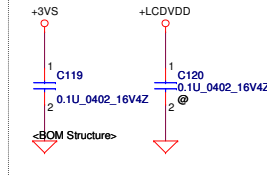
Intel recommends having a pull-up resistor of 100 kΩ for AUXN and a pull-down resistor of 100 kΩ for AUXP between the AC capacitor and the connector, to assist source detection by the sink device.
All reverse on before project.



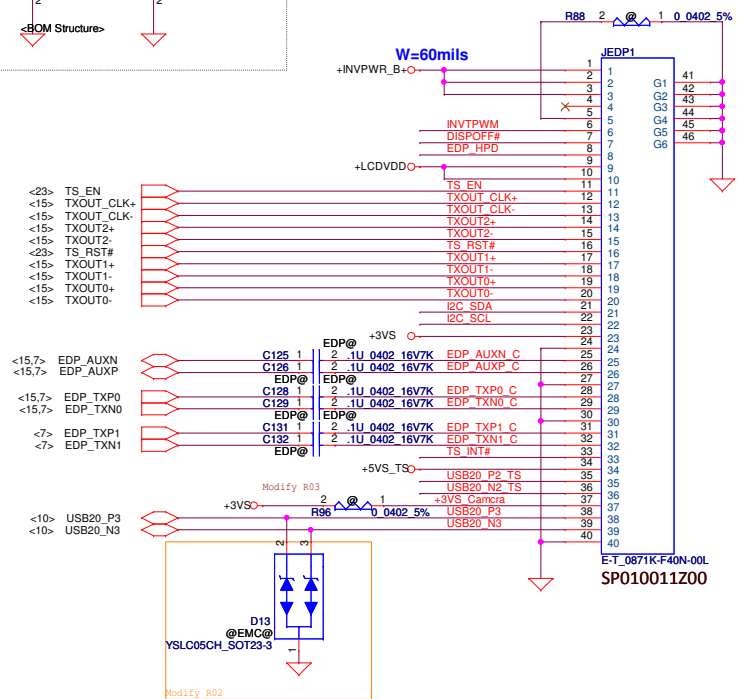
For Select LVDS EDID or EDP I2C touch



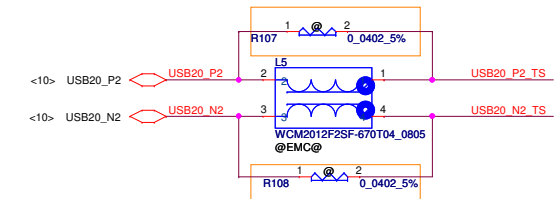
Place closed to JLVDS1



LCD/ LED PANEL Conn.

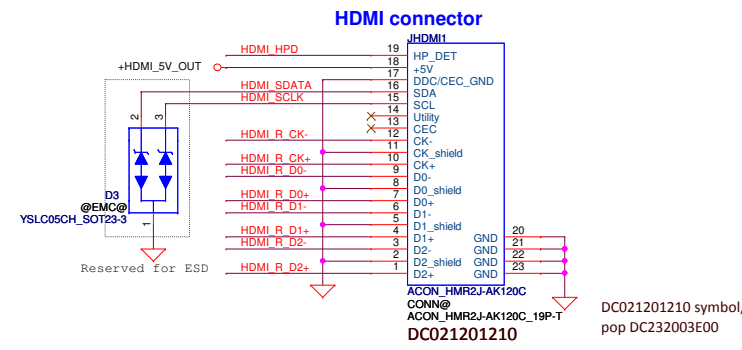
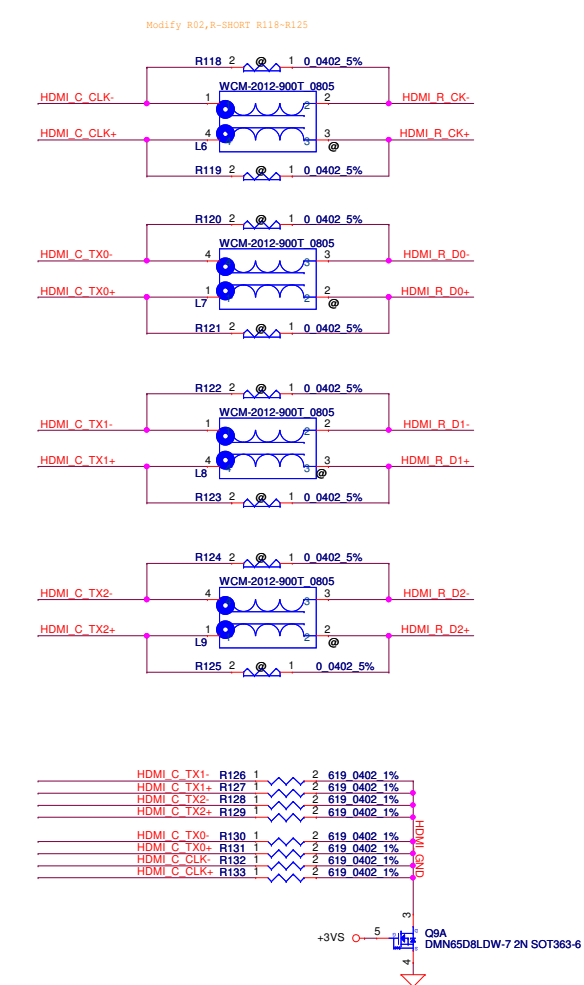
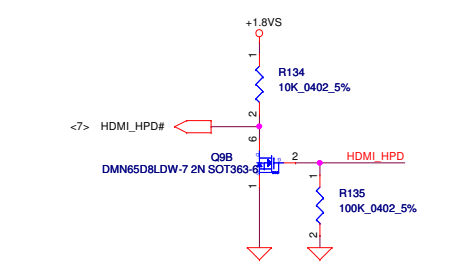
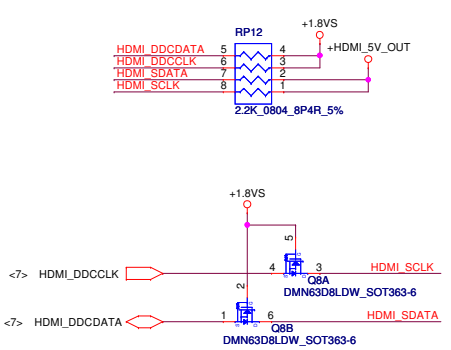
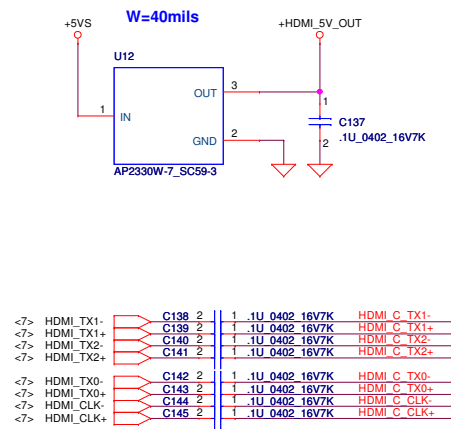


Touch



Solution	Panel	Touch	BOM option
Cable 1	eDP	I2C,USB	EDP@,TS@
Cable 2	LVDS	USB	LVDS@

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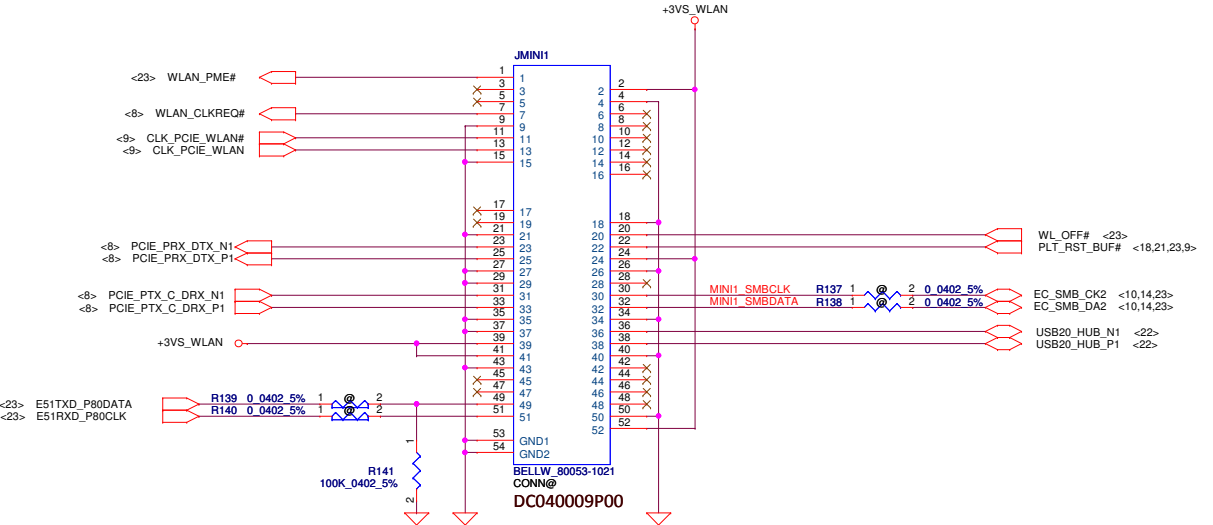
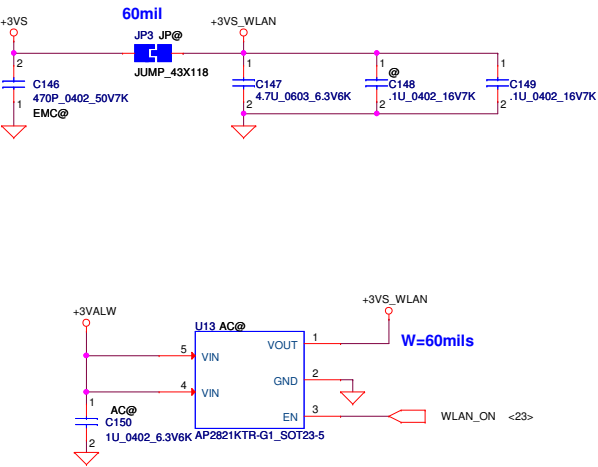


ZZZ

HDMI_ROYALTY
ROYALTY HDMI W/LOGO+HDCP
R00000003HM
45@

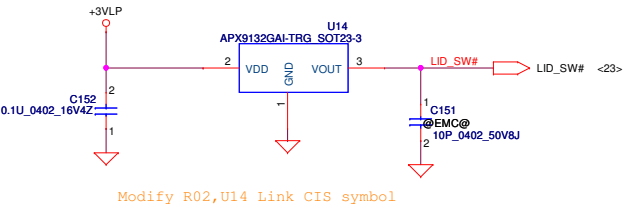
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Issued Date	2013/04/12	Deciphered Date	2014/04/12	HDMI CONN.
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For Wireless LAN



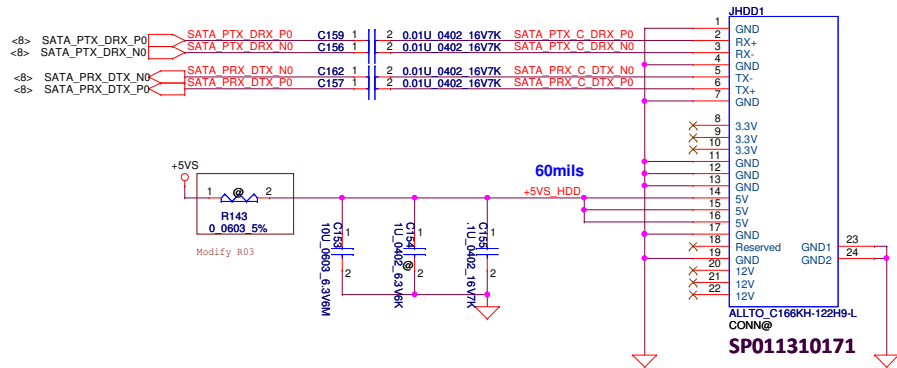
Hall sensor

Lid Switch
(Hall Effect Switch)

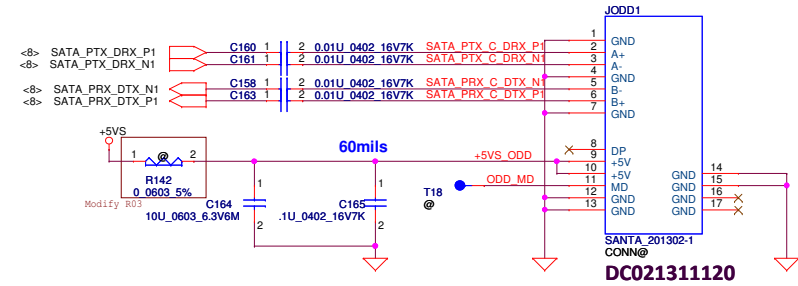


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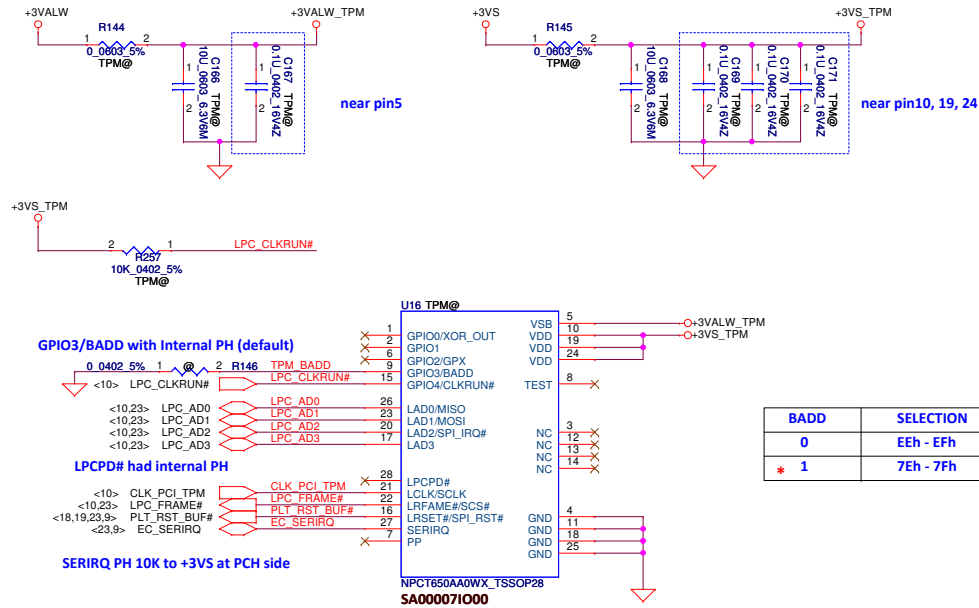
SATA HDD1 Conn.



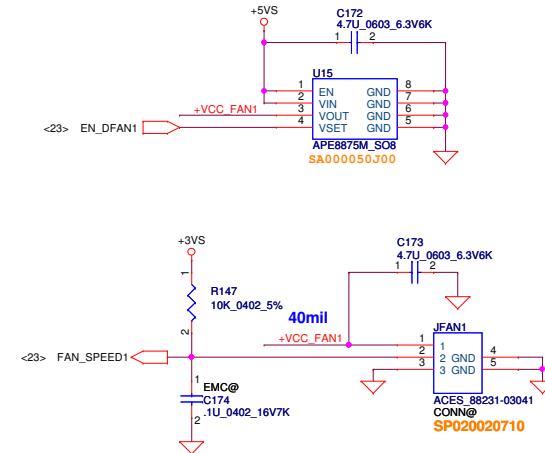
SATA ODD Conn.

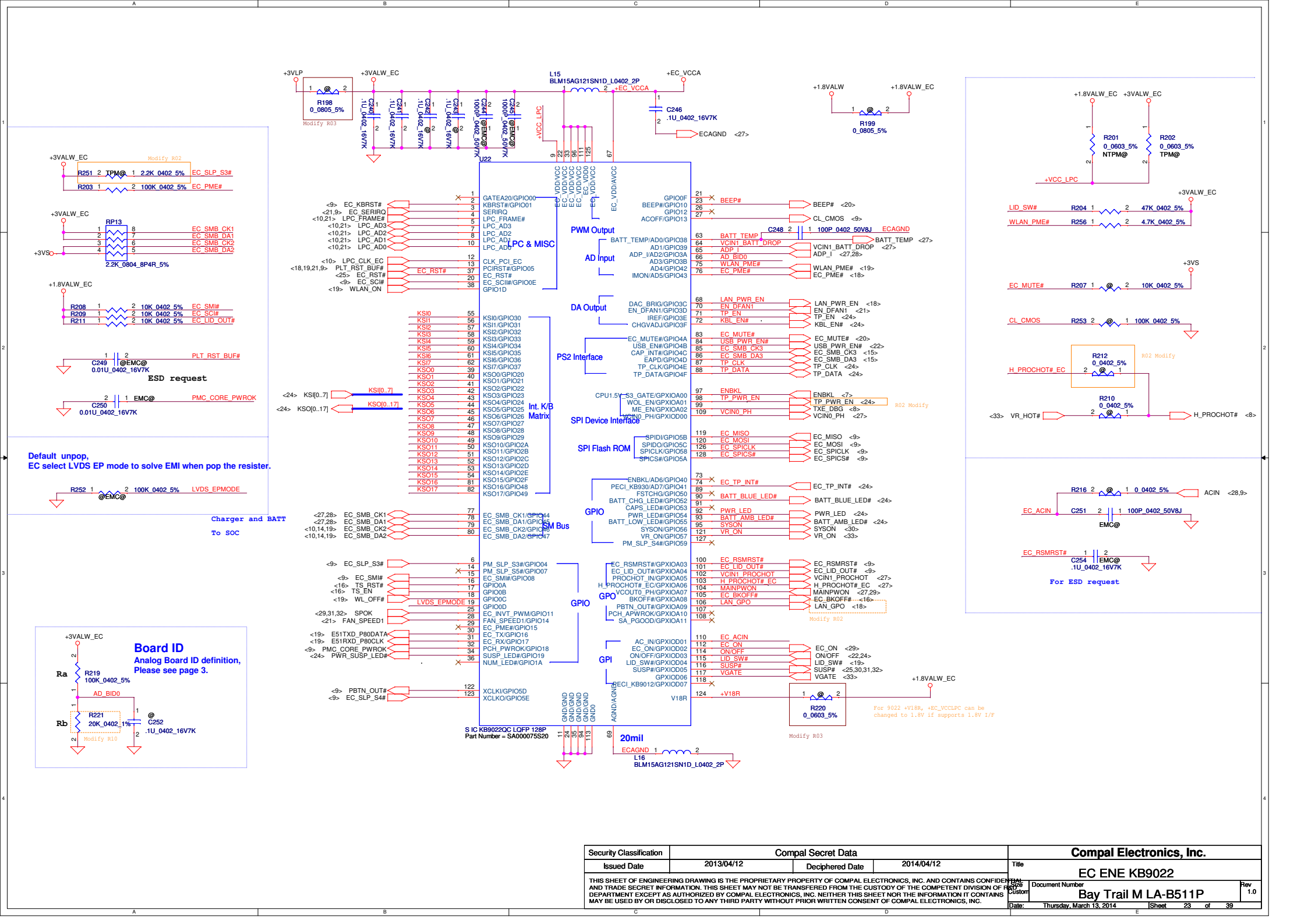


TPM

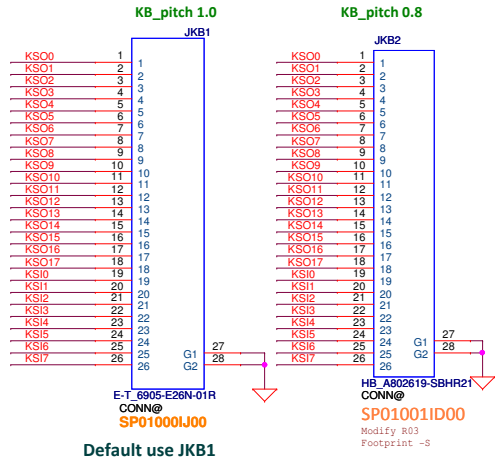


FAN1 Conn

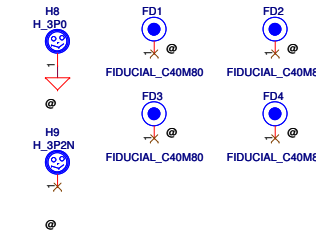
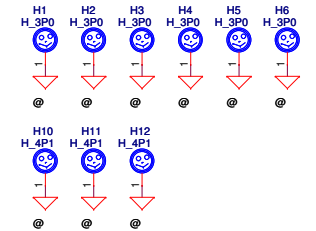
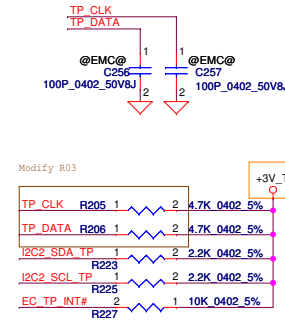
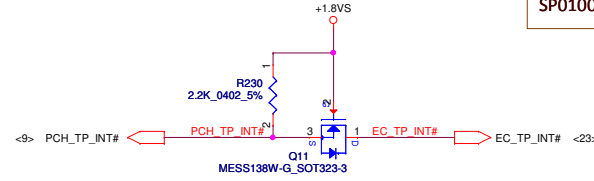
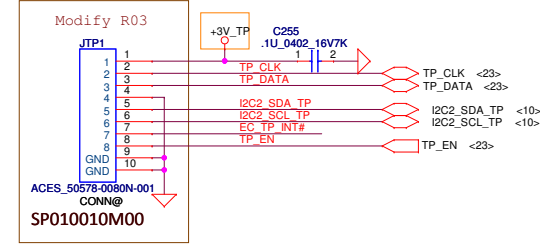
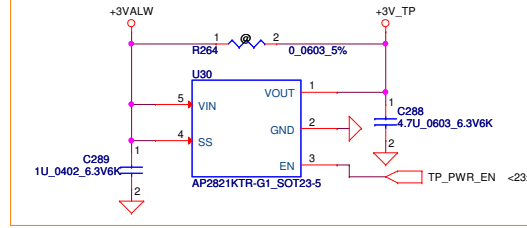




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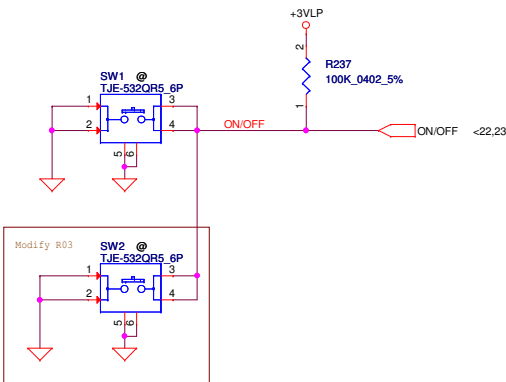


To TP/B Conn.

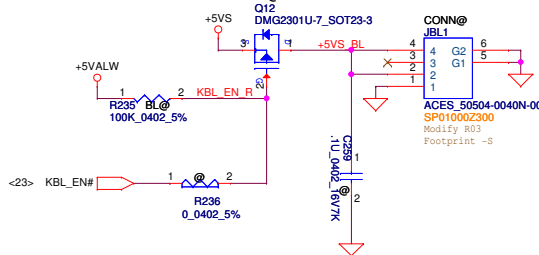


Event	PCH_TP_INT#	EC_TP_INT#
S0	Interrupt	X
S3	X	Wake
1. Clamshell closed or Lid closed	X	X
2. Tablet mode for Convertible design	X	X
3. Disable TP function by hot-key	X	X

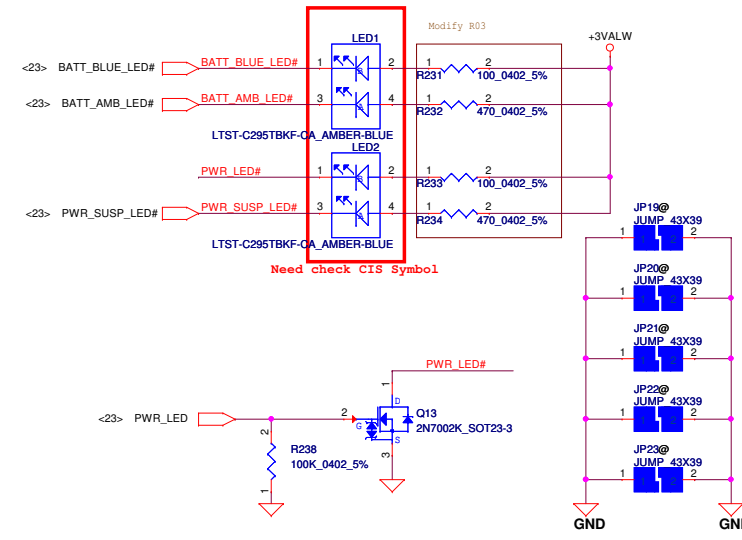
ON/OFF BTN



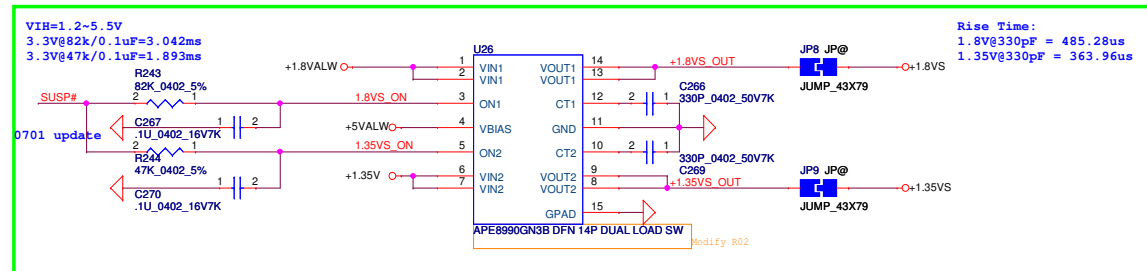
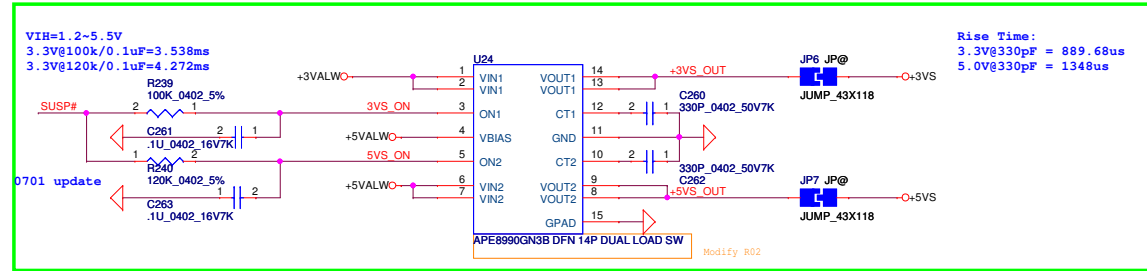
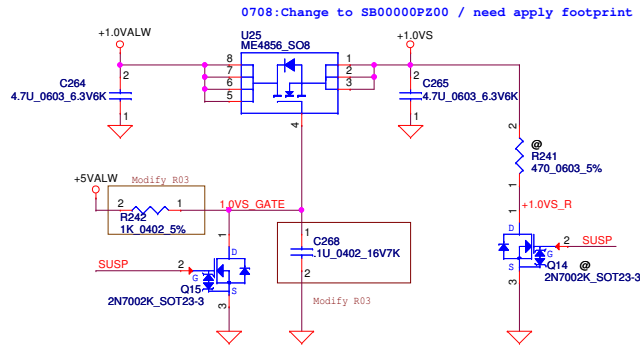
KB BackLight Conn.



LED

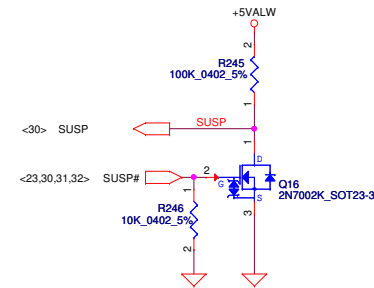
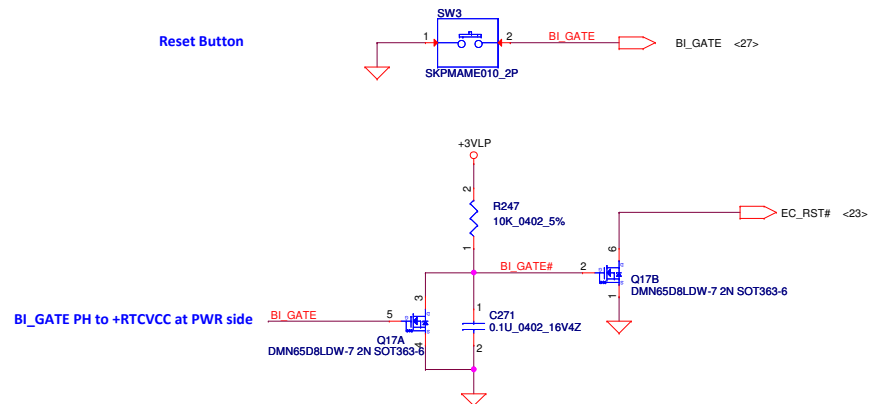


+1.0VALW TO +1.0VS

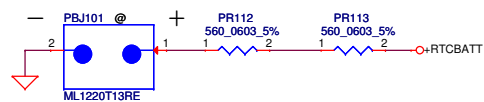
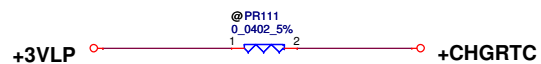
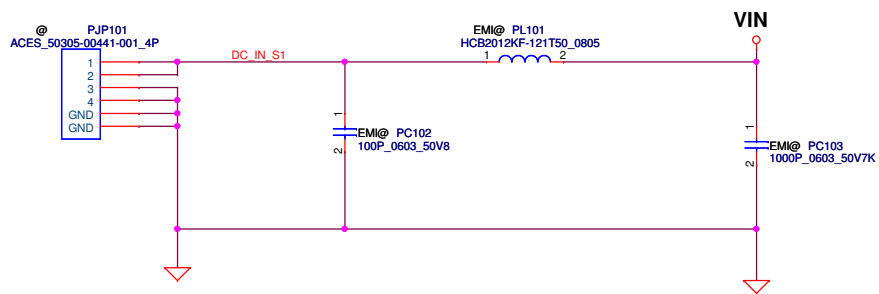


Reset Button / Battery discharge screw hole

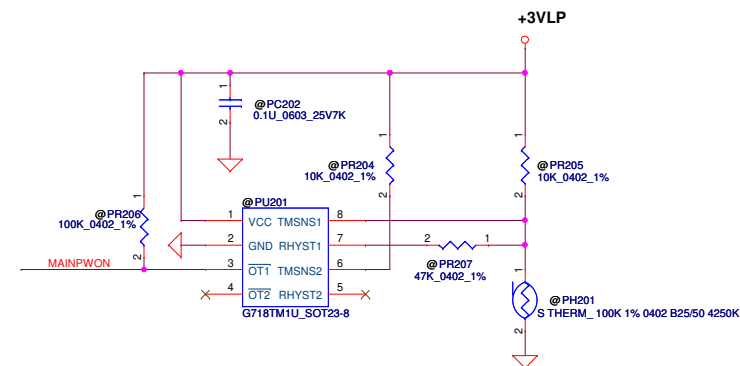
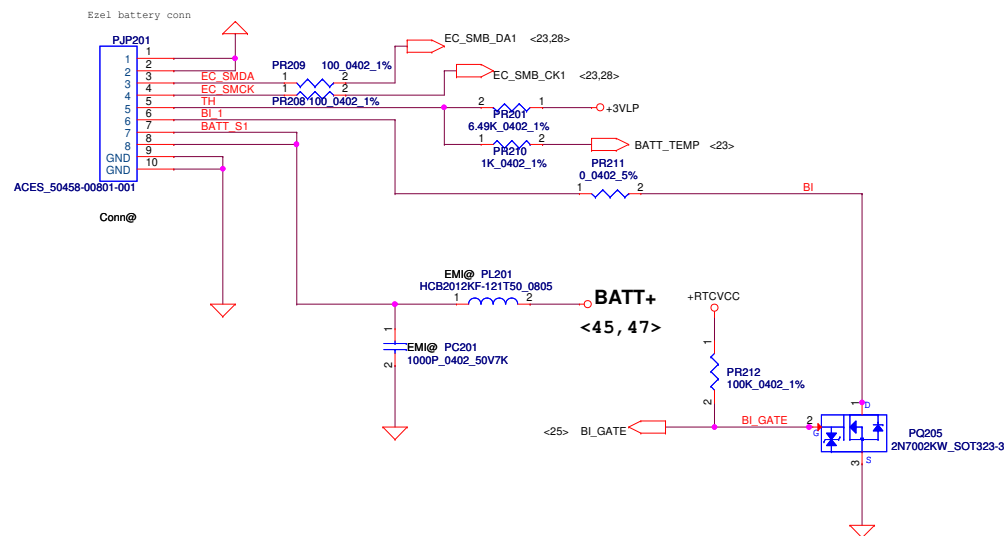
Follow VAS2_HB design



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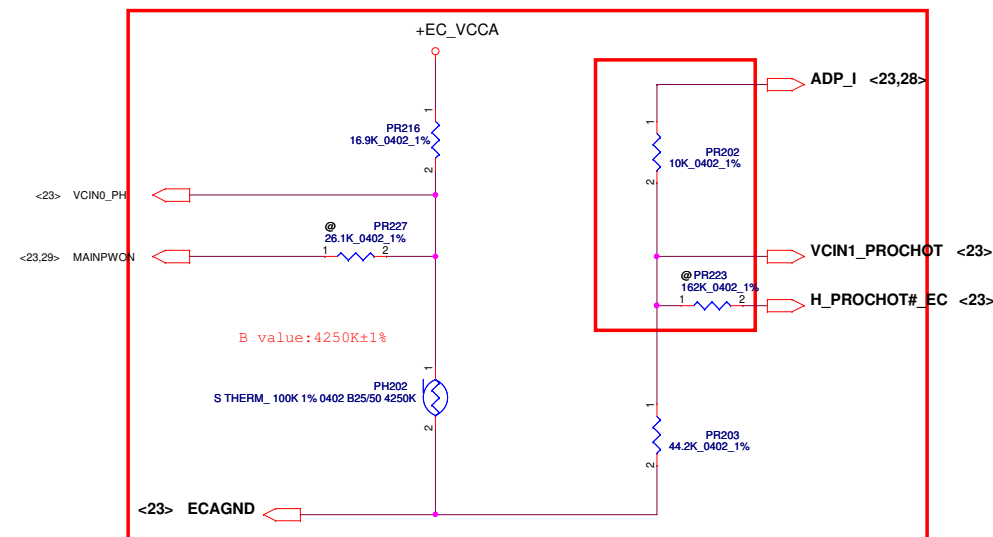
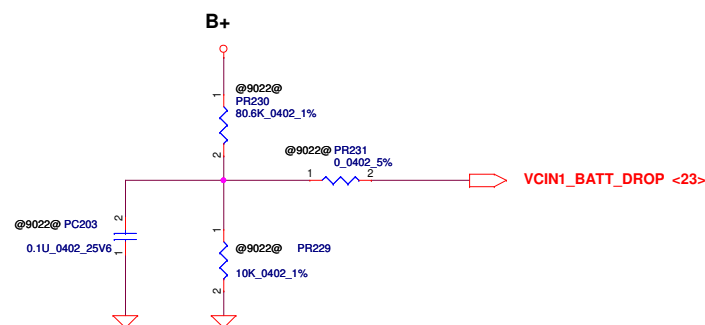
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	For KB9012 OTP	For KB9022 OTP
92°C	1.2V	1.0V
56°C	1.2V	1.0V
PR216	22.6K ohm	32.4K ohm
PR227	26.1K ohm	30.9K ohm

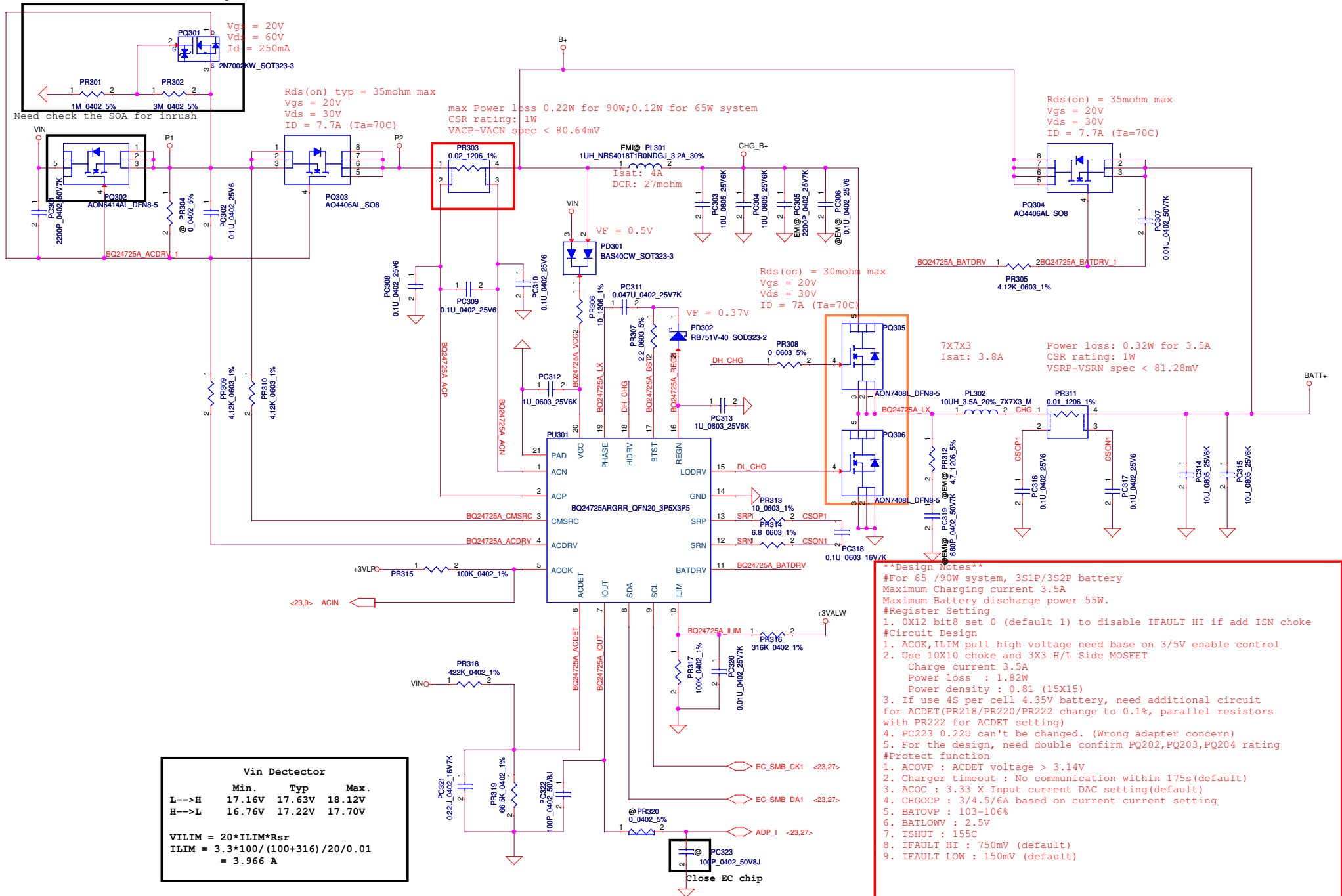
Need confirm the setting

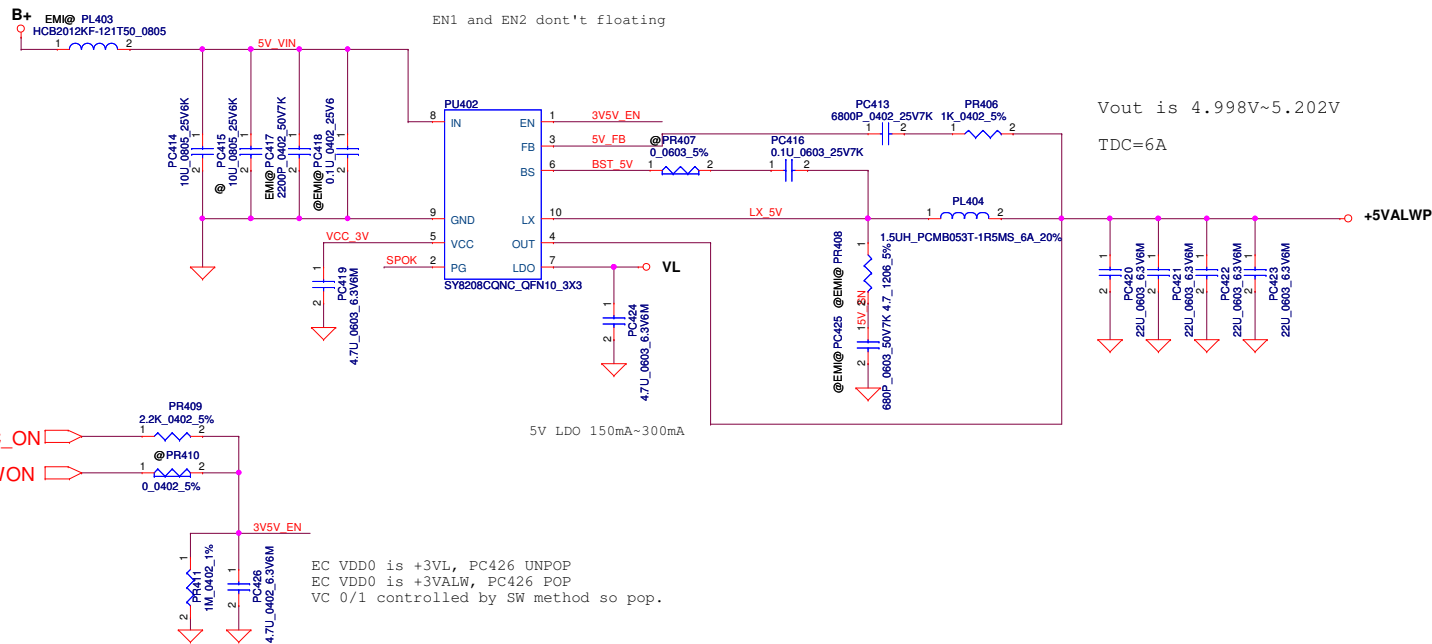
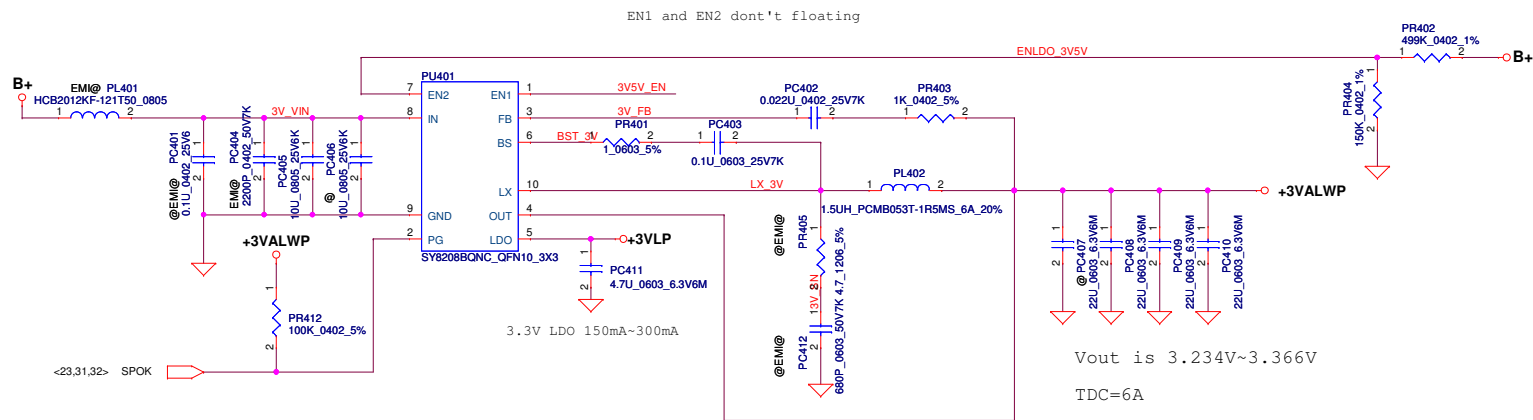
For KB9022 sense 20mΩ	Active	Recovery
40W	42.8W, 0.43V	34.4W, 0.43V



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								Size		Document Number		Rev	
								Custom		Bay Trail M LA-B511P		1.	
Date:				Thursday, March 13, 2014		Sheet		27		of 39			

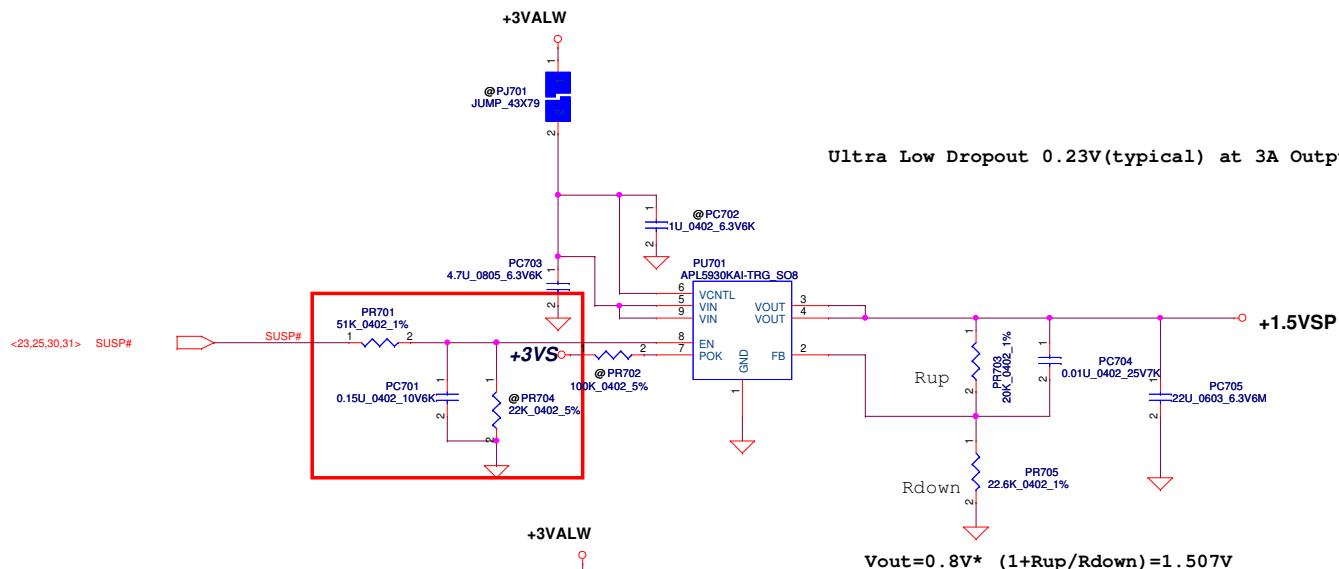
Protection for reverse input





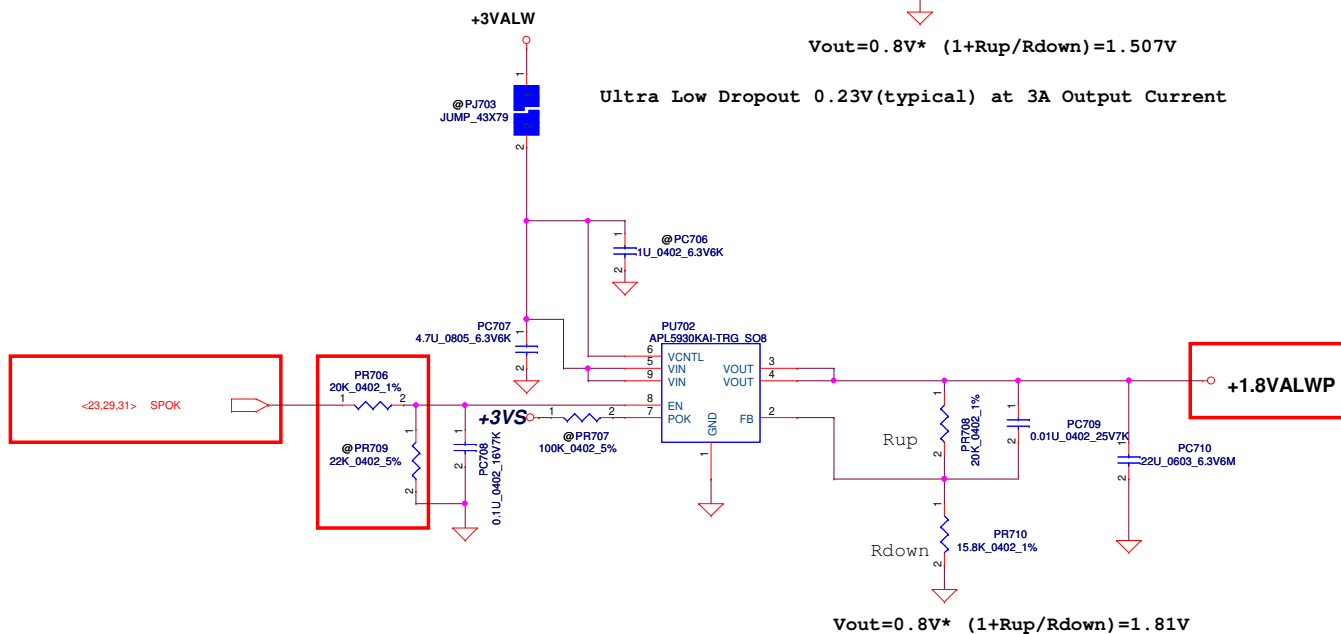
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Ultra Low Dropout 0.23V(typical) at 3A Output Current



$$V_{out} = 0.8V * (1 + R_{up}/R_{down}) = 1.507V$$

Ultra Low Dropout 0.23V(typical) at 3A Output Current



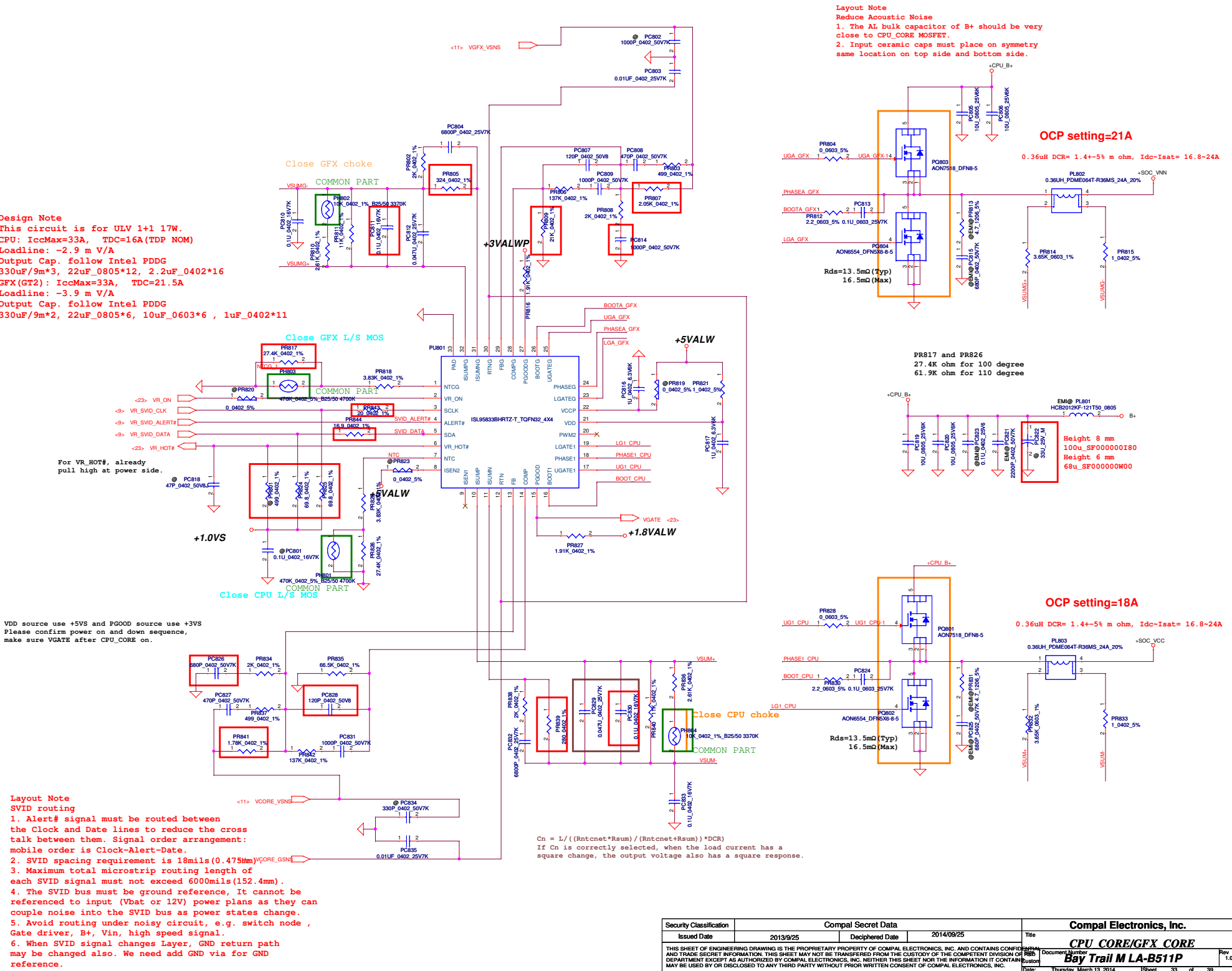
$$V_{out} = 0.8V * (1 + R_{up}/R_{down}) = 1.81V$$

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Design Note
This circuit is for ULV i+1 17W.
CPU: IccMax=33A, TDC=16A(TDP NOM)
Loadline: -2.9 m V/A
Output Cap. follow Intel PDDG
330uF/9m*3, 22uF_0805*12, 2.2uF_0402*16
GFX(GT2): IccMax=33A, TDC=21.5A
Loadline: -3.9 m V/A
Output Cap. follow Intel PDDG
330uF/9m*2, 22uF_0805*6, 10uF_0603*6, 1uF_0402*11

VDD source use +5VS and PG00D source use +3VS
Please confirm power on and down sequence,
make sure VGATE after CPU_CORE on.

Layout Note
SVID routing
1. Alert# signal must be routed between the Clock and Date lines to reduce the cross talk between them. Signal order arrangement: mobile order is Clock-Alert-Date.
2. SVID spacing requirement is 18mils(0.475mm)
3. Maximum total microstrip routing length of each SVID signal must not exceed 6000mils(152.4mm).
4. The SVID bus must be ground reference, it cannot be referenced to input (Vbat or 12V) power plans as they can couple noise into the SVID bus as power states change.
5. Avoid routing under noisy circuit, e.g. switch node, Gate driver, B+, Vin, high speed signal.
6. When SVID signal changes Layer, GND return path may be changed also. We need add GND via for GND reference.



Layout Note
Reduce Acoustic Noise
1. The AL bulk capacitor of B+ should be very close to CPU_CORE MOSFET.
2. Input ceramic caps must place on symmetry same location on top side and bottom side.

OCP setting=21A
0.36uH DCR= 1.4+-5% m ohm, Idc=Isat= 16.8-24A

OCP setting=18A
0.36uH DCR= 1.4+-5% m ohm, Idc=Isat= 16.8-24A

PR817 and PR826
27.4K ohm for 100 degree
61.9K ohm for 110 degree

Height 8 mm
100u_SF0000000180
Height 6 mm
68u_SF0000000000

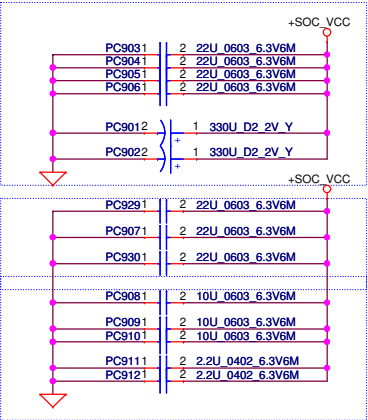
$C_n = L / ((R_{ntcnet} * R_{sum}) / (R_{ntcnet} + R_{sum})) * DCR$
If C_n is correctly selected, when the load current has a square change, the output voltage also has a square response.

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PWR Rule
需確認最新SPEC.
Modify 8/6.

3 X 330u/9m(47W)
2 X 330u/9m(37W)
24 pcs 22uF and reserve 4 pcs
2013/08/16

+SOC_VCC =+CPU_CORE

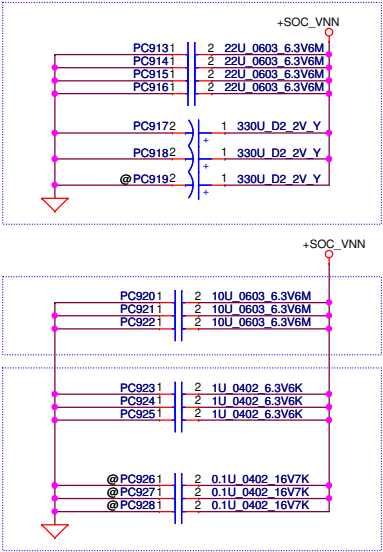


Output Cap
(330uF*3+22uF*4)

Package Edge Cap
(22uF*3)

Back Side Cap
(1uF*3)

+SOC_VNN =+VGFX_CORE



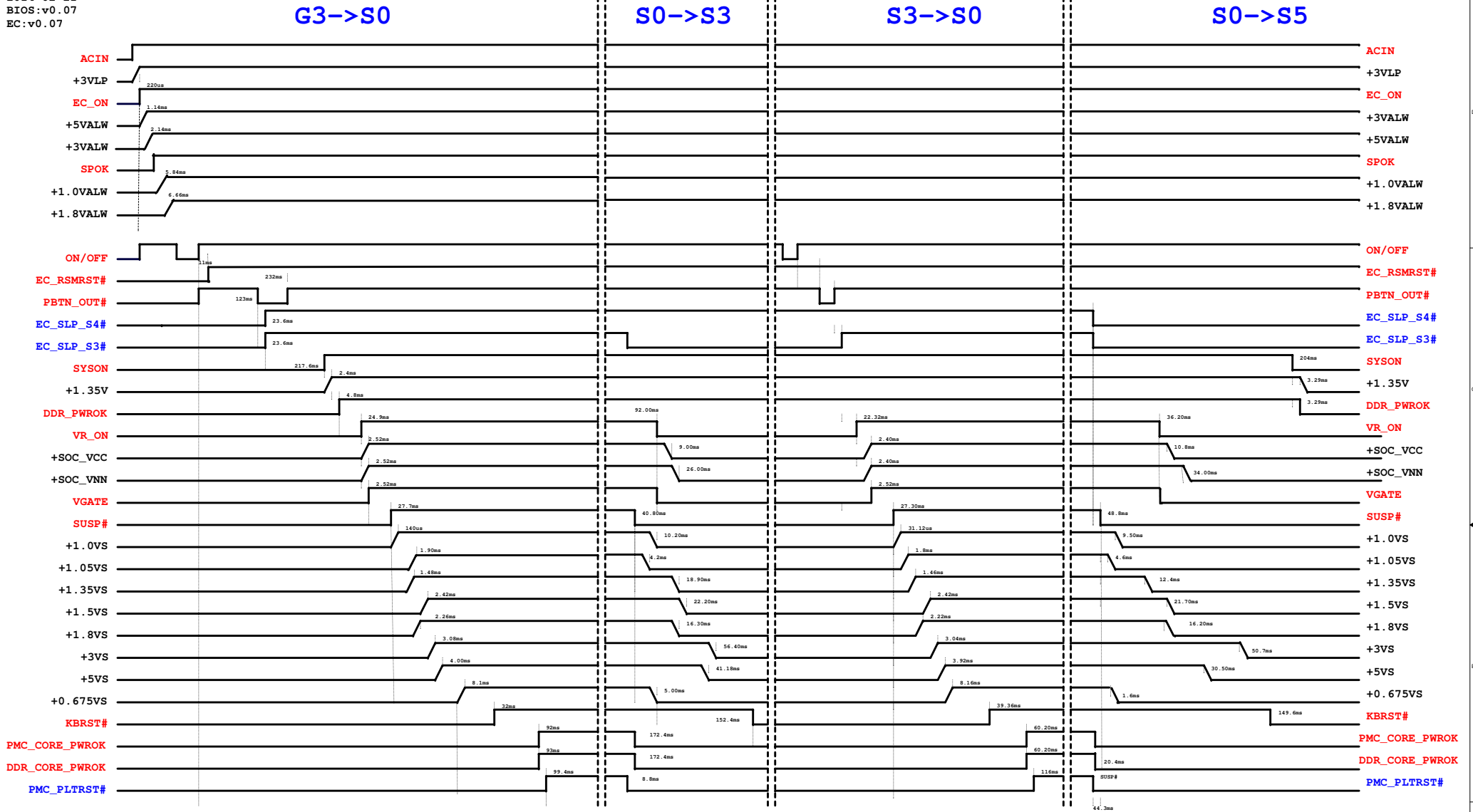
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Issued Date	2013/9/25	Deciphered Date	2014/09/25	Title	CPU/GFX capacitor
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Version change list (P.I.R. List)

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for PWR

Item	Fixed Issue	Reason for change	Rev.	PG#	Modify List	Date	Phase
1		Improve ripple voltage		30	Change PL602 from SH000000YE00 to SH0000008800	12/30	DVT
2		Improve part rating		33	Change PC901,PC902,PC917,PC918 from SGA000026800 to SGA20331E10	12/31	DVT
3	HW request	Use bead(L22) individ		29	Delete PJ501, PJ502	01/07	DVT
4		Unify VC0/VC1 setting		26	Change PR202, PR203, PR216	01/08	DVT
5		Raise part rating		32	Change PR814, PR832 size from 0402 to 0603	01/10	DVT
6		Prevent burn issue		27	Change PQ303, PQ304 from AO4466L to AO4406AL	01/10	DVT
7	Customer request			26	Change PR211 from 100 to 0	01/29	PVT
8		VC 0/1 controlled by sw method		28	Pop PC426	01/29	PVT
9		Meet EC request		32	Change +1.8VALW for VGATE pull high	02/18	PVT
10							
11							
12							
13							
14							
15							
12							
13							
14							
15							
16							
17							

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Version Change List (P. I. R. List)

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Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	P.08		12/17	HW	SLP_S3# leak voltage	Change Q21 direction	0.2
2	P.09		12/17	HW	GPIO_S0_SC_56 pull down no vedio. Touch screen and touch pad SMBus net fail NO support CPU Thermal sensor	Pop R53, unpop R55 Change Q2.1 to SOC_I2C5_CLK Change Q3.1 to SOC_I2C2_CLK Unpop U28	0.2
3	P.14		1/6	HW	U9 DP to LVDS chip old symbol	Link CIS for SA00007A300	0.2
4	P.18		1/6	HW	U14 Lid switch old symbol	Link CIS for SA000079D00	0.2
5	P.19		1/6	HW ESD	Vendor request to meet Acer spec ESD test Fail	Change R188,R192 from 47ohm to 60.4ohm Add C277,C278,L19,L20 for RING2 & SLEEVE Change D9 pin2.3 name to RING2_L & SLEEVE_L	0.2
6	P.6,8,11,15, 16,17,19,22		1/6	HW	0 ohm R-short	R13,R71,R72,R118,R119,R120,R121,R122, R123,R124,R125,R34,R36,R200,R254,R255, R172,R187,R193,R167,R168,R169,R170, R187,R193,R107,R108,R212	0.2
7	P.17		1/6	HW	Change LAN power	Unpop U19,C188 Pop R160,R200 change R200.2 from LAN_PWR_EN to LAN_GPO Change C204,C205 from 12pF to 10pF	0.2
8	P.22		1/6	HW	Add EC GPIO Board ID	Add LAN_GPO for U22.pin106 Change R211 to 12K	0.2
9	P.15		1/6	ESD		Add D13	0.2
10	P.21		1/6	HW	Change USB HUB to GL850S	Delete U18,R152~R157,C182~C187,Y3 Add U29,R259~R263,C279~C287,Y5	0.2
11	P.19		1/6	HW	BOM	Change C215,C273 from SE107105ML0 to SE080105K80.	0.2
12	P.8		1/6	HW		Change R34.2 from TS_INT#_CPU to SOC_TS_INT# Change R36.2 from TP_INT#_CPU to SOC_TP_INT#	0.2
13	P.13		1/7	EMI		Add L21,L22 for EMI Change net name to +1.35V_L C91~C102,R77,R75,(JDIMM1 pin75,76,81,82,87,88, 93,94,99,100,105,106,111,112,117,118,123,124)	0.2
14	P.23		1/7	HW		Add U30,C288,C289,R264 for +3V_TP Change JTP1.8,R233.2,R225.2,R227.2 to +3V_TP	0.2

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Version Change List (P. I. R. List)

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Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
15	P.24		01/07	HW	BOM	Change U24,U26 to SA00006FD00	0.2
16	P.9,23		01/08	HW	BOM	Delete TP@ BOM structure ==> C255,Q11,R223,R225,R227,R230,R63,R64,Q3	0.2
17	P.8,15,17 19,22		01/08	HW	BOM	R-short==>R34,R36,R200,R254,R255,R172,R187, R193,R167,R168,R169,R170,R187,R193,R107,R108, R212,R150,R151,R248,R249	0.2
18	P.23 P.08		01/08	HW	BOM	Pop U30,C288,C289 Unpop R264 Pop U30,C288,C289 Unpop R264	0.2
19	P.23 P.22		01/08	HW		Change U30.3 from SYSON to TP_PWR_EN Add U22.98 TP_PWR_EN	0.2
20	P.21		01/08	ME		JUSB2 Link CIS symbol ==> ACES_51524-0140N-001	0.2
21	P.21		01/13	HW		USB2.0 port0 USB3.0 conn. USB2.0 port1 USB HUB	0.2
22	P.9,14		01/14	HW		Change RP10,RP11 to 2.2K_0804_8P4R	0.2
23	P.15		01/14	HW	BOM	ETS@ BOM structure ==> R101,R102,R113,R114	0.2
24	P.21		01/16	HW	BOM	BOM structure==>Add U16,R257 to TPM@	0.2
25	P.09		02/18	HW	BOM	For +1.8VS abnormal voltage Pop R28	0.3
26	P.20		02/18	HW		For HP pop noise Change R188,R192 to 0ohm Change R187,R193 to 60.4ohm	0.3
27	P.24		02/18	HW		For TP Change R205,R206 to +3V_TP Change JTP1 pin define	0.3
28	P.23		02/18	HW		For Board ID Pop R219 Change R221 to 15K	0.3
29	P.25		02/18	HW		For +1.0 VS Pop C268, Change R242 to 1K	0.3
30	P.24		02/18	HW		unpop SW2	0.3

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Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
31	P. 20, 24		02/21	ME		JKB2, JBL1, JDMIC1 蓋綠漆. Change footprint to XXXX-S	0.3
32	P. 9, 21, 22, 23		02/21	HW		R-short R40, R96, R143, R142, R259, R198, R199, R220	0.3
32	P. 9		02/21	HW		Add JCMOS2	0.3
33	P. 24		02/21	ME		測光 Chang R231, R233 to 100 ohm Change R232, R234 to 470 ohm	0.3
34	P. 22		02/24	HW		Change USB HUB to GL850G Add U31, R265, R266, R267 Delete U29, R262	0.3
35	P. 09		02/25	HW		32.768KHz Change C17, C18 to 18pF	0.3
36	P. 17, 20, 25		02/26	HW		Change Q9, Q17, Q18 from SB00000DH00 to SB00000ZU00	0.3
37	P. 16		03/12	HW		R-short R88	1.0
38	P. 23		03/13	HW		For Board ID Change R221 from 15K to 20K	1.0
39	P. 24		03/13	HW		Change SW1 from DBG@ to @	1.0

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